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Sun et al.

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(54) **SEE-THROUGH METROLOGY SYSTEMS, APPARATUS, AND METHODS FOR OPTICAL DEVICES**

(71) Applicant: **Applied Materials, Inc.**, Santa Clara, CA (US)

(72) Inventors: **Yangyang Sun**, San Jose, CA (US); **Jinxin Fu**, Fremont, CA (US); **Kazuya Daito**, Milpitas, CA (US); **Ludovic Godet**, Sunnyvale, CA (US)

(73) Assignee: **Applied Materials, Inc.**, Santa Clara, CA (US)

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G06T 7/00 (2017.01)
G06T 7/90 (2017.01)
(Continued)

(52) **U.S. Cl.**
CPC ***G06T 7/001*** (2013.01); ***G01J 1/42*** (2013.01); ***G01J 1/44*** (2013.01); ***G01N 21/958*** (2013.01); ***G02B 27/0172*** (2013.01); ***G06T 7/80*** (2017.01); ***G06T 7/90*** (2017.01); ***H04N 23/56*** (2023.01); ***H04N 23/74*** (2023.01); ***H04N 23/90*** (2023.01); *G01J 2001/4247* (2013.01); *G01N 2021/9583* (2013.01); *G02B 2027/014* (2013.01);
(Continued)

(58) **Field of Classification Search**
CPC ... G06T 7/001; G06T 7/80; G06T 7/90; G01J 1/42; G01J 1/44; G01N 21/958; G02B 27/0172; H04N 5/2256; H04N 5/2354; H04N 5/247
USPC 345/8; 700/114; 250/578.1
See application file for complete search history.

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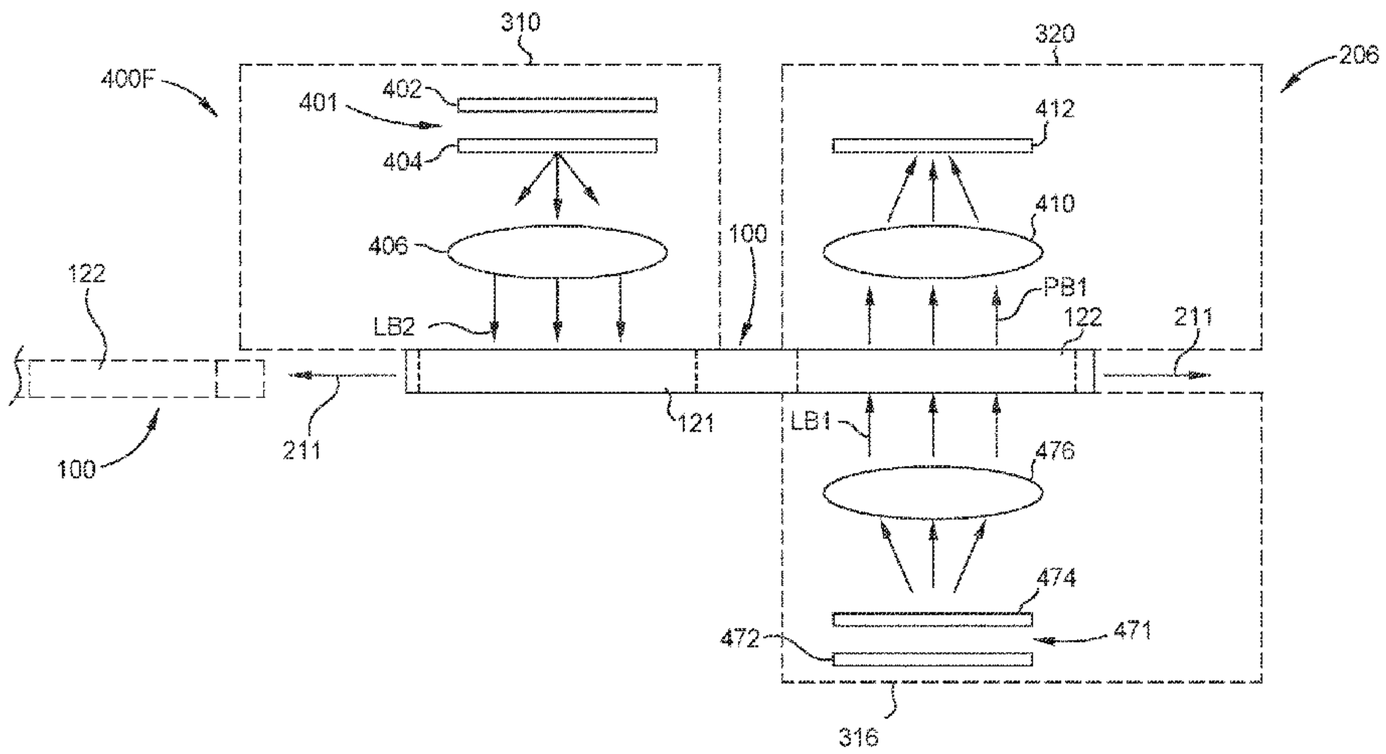
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Primary Examiner — Prabodh M Dharia
(74) *Attorney, Agent, or Firm* — Patterson + Sheridan, LLP

(57) **ABSTRACT**

Embodiments of the present disclosure relate to optical devices for augmented, virtual, and/or mixed reality applications. In one or more embodiments, an optical device metrology system is configured to measure a plurality of see-through metrics for optical devices.

17 Claims, 20 Drawing Sheets



(51) **Int. Cl.**

G06T 7/80	(2017.01)
G01J 1/42	(2006.01)
G02B 27/01	(2006.01)
G01J 1/44	(2006.01)
G01N 21/958	(2006.01)
H04N 23/56	(2023.01)
H04N 23/74	(2023.01)
H04N 23/90	(2023.01)

(52) **U.S. Cl.**
CPC *G02B 2027/0112* (2013.01); *G02B 2027/0118* (2013.01); *G02B 2027/0138* (2013.01); *G06T 2207/10024* (2013.01); *G06T 2207/30108* (2013.01)

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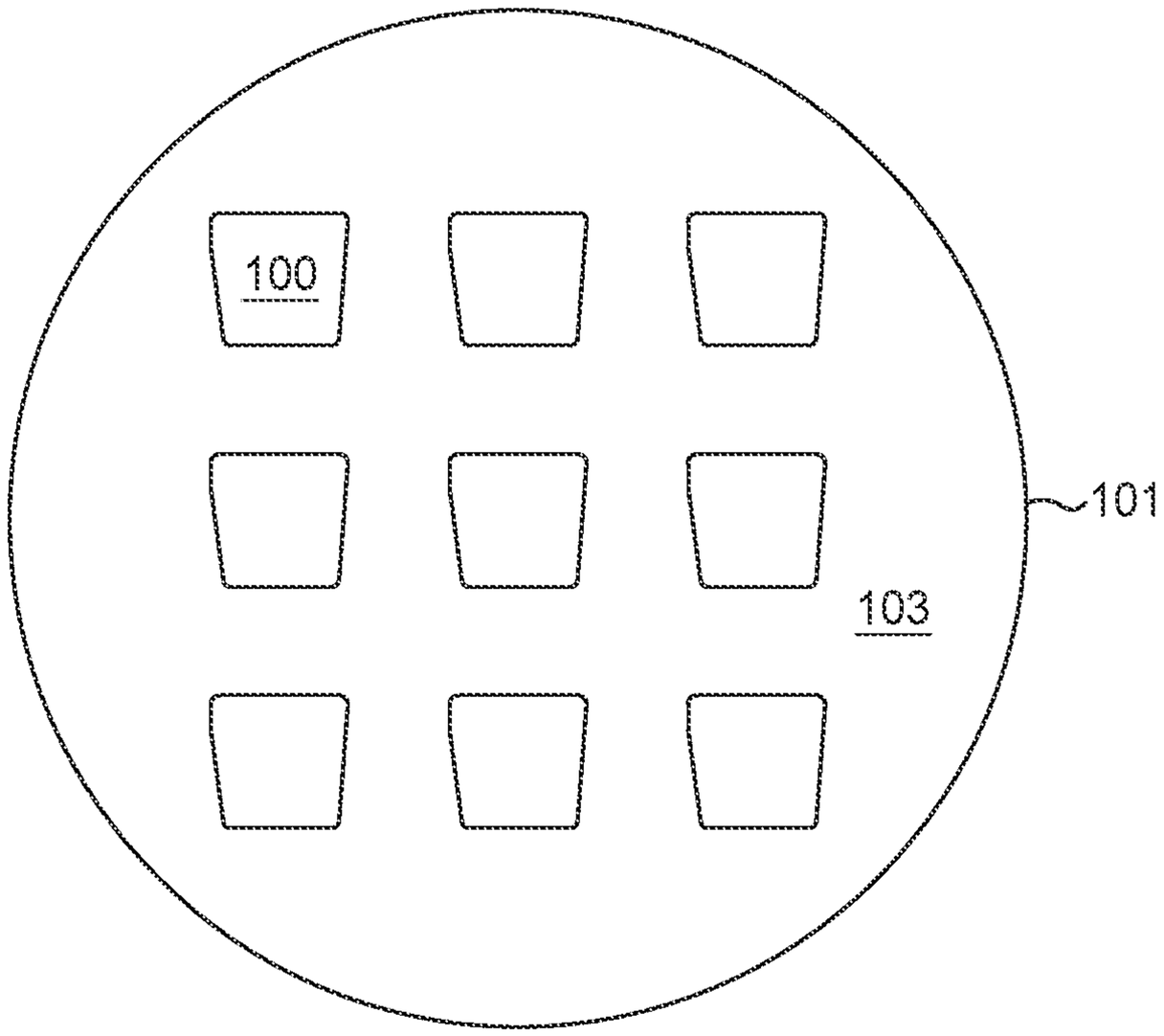


FIG. 1A

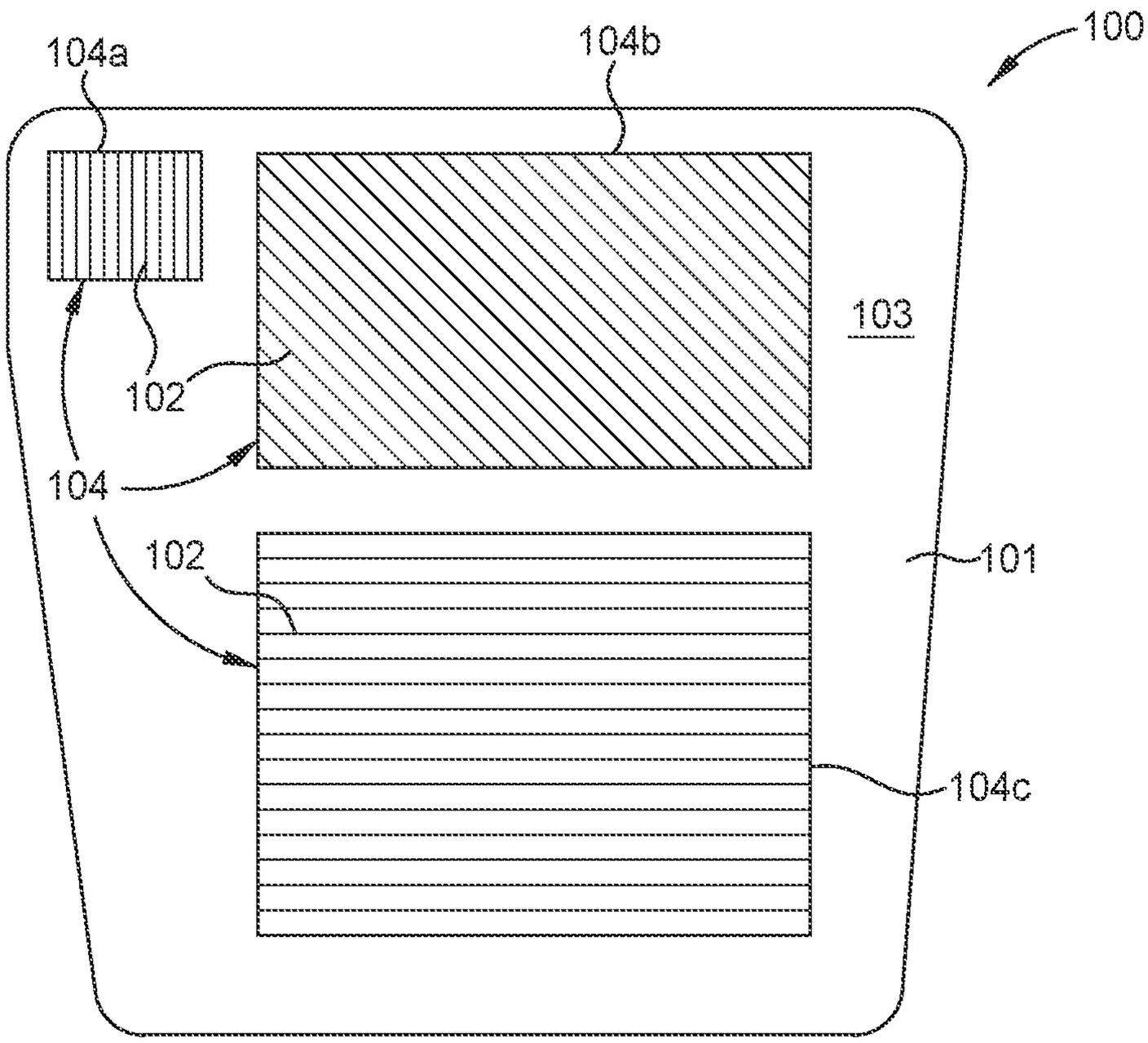


FIG. 1B

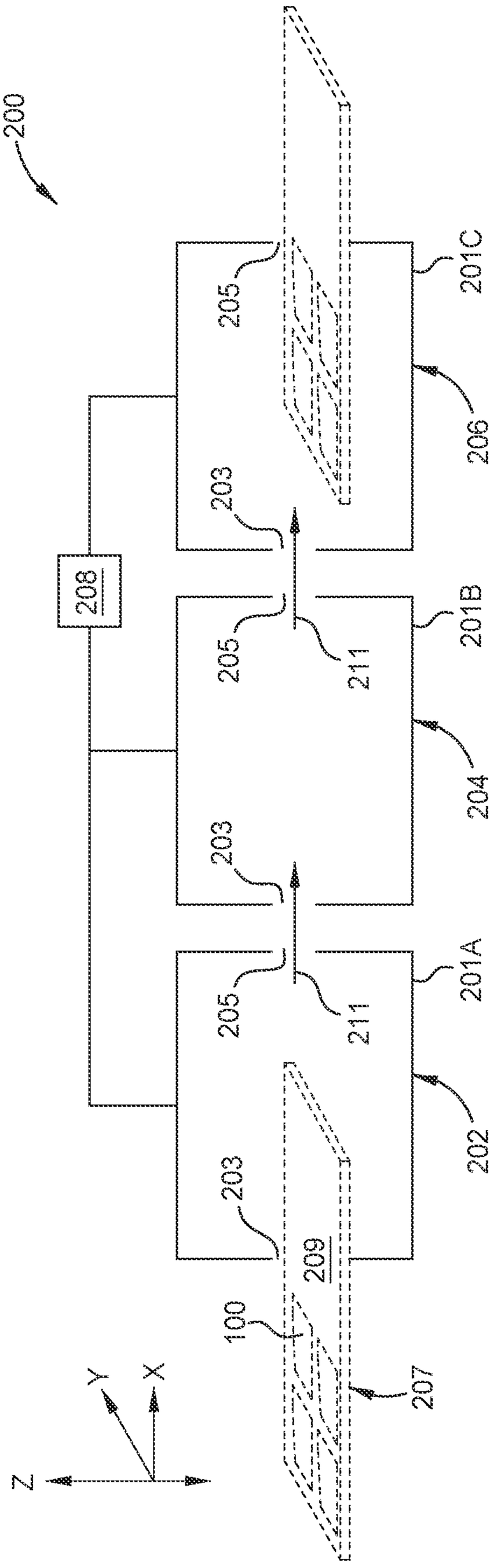

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FIG. 2

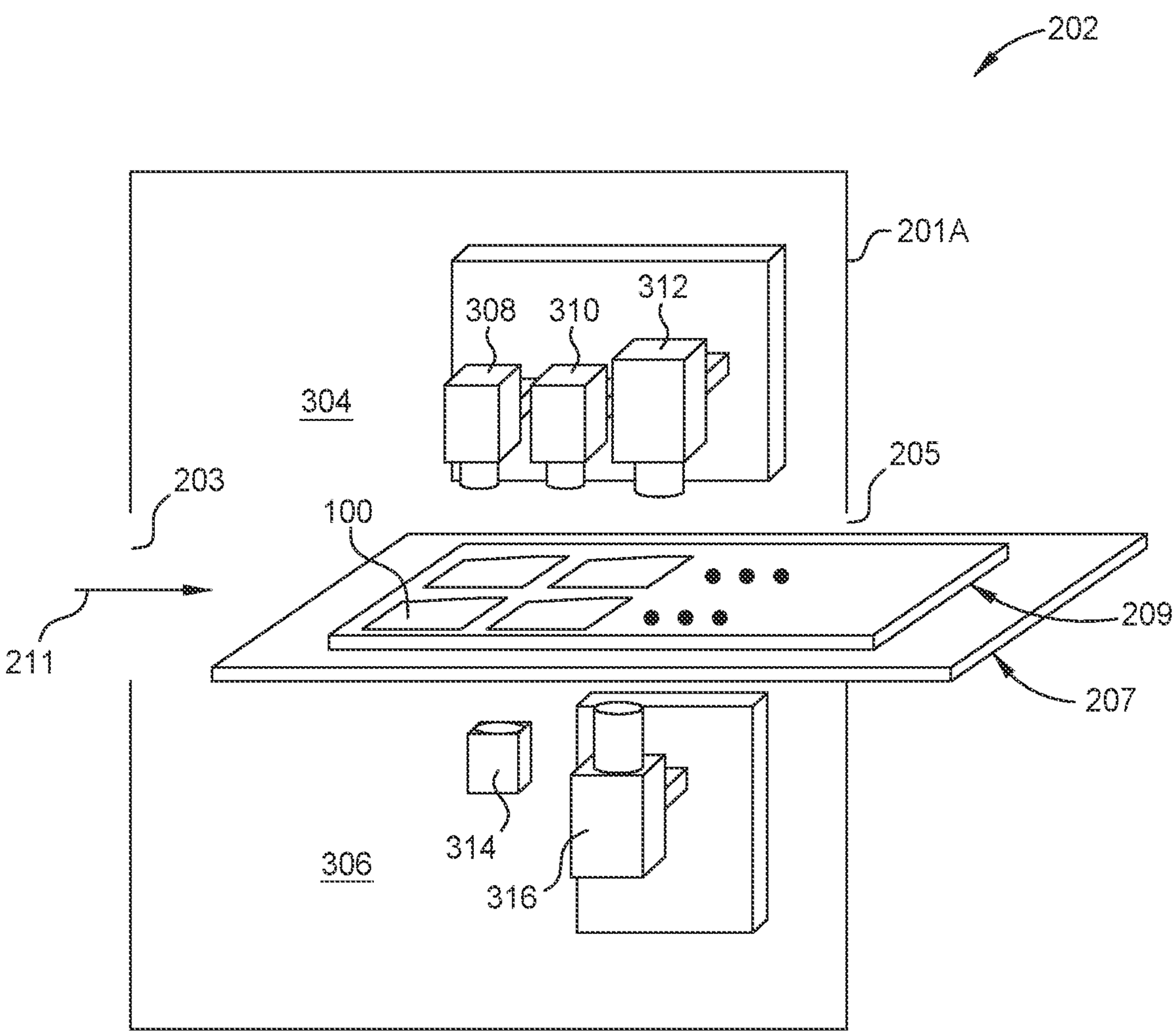


FIG. 3A

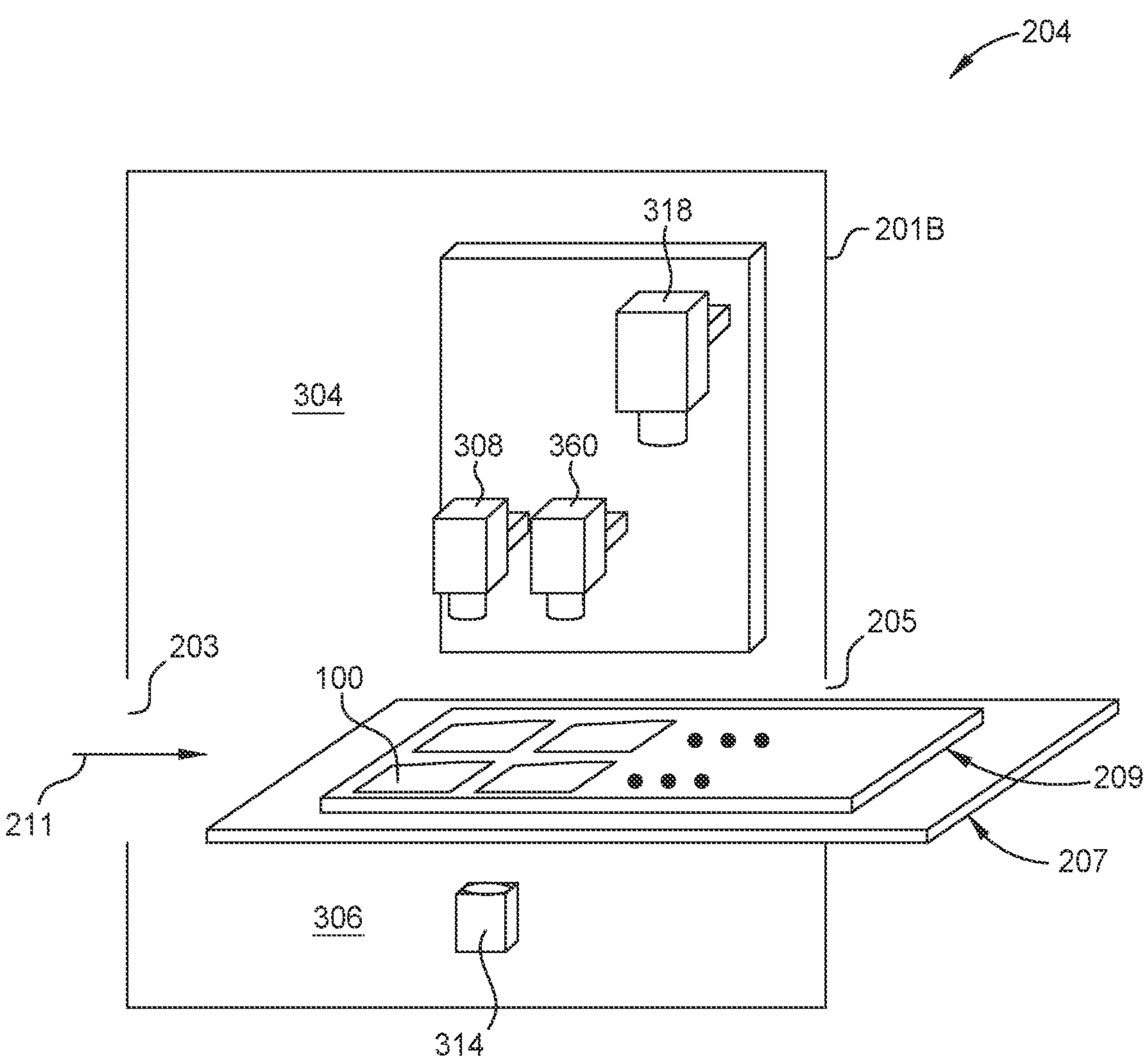


FIG. 3B

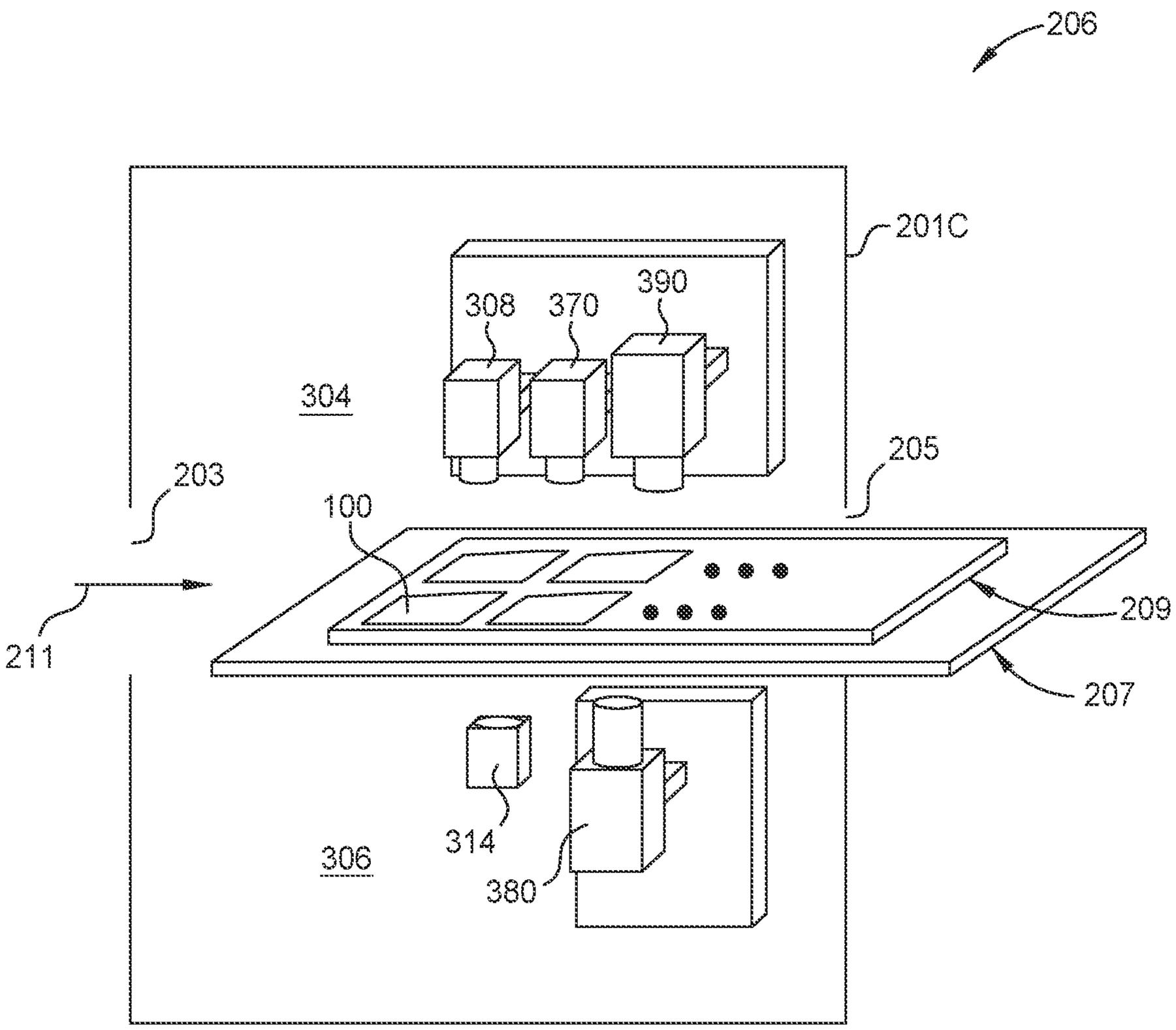


FIG. 3C

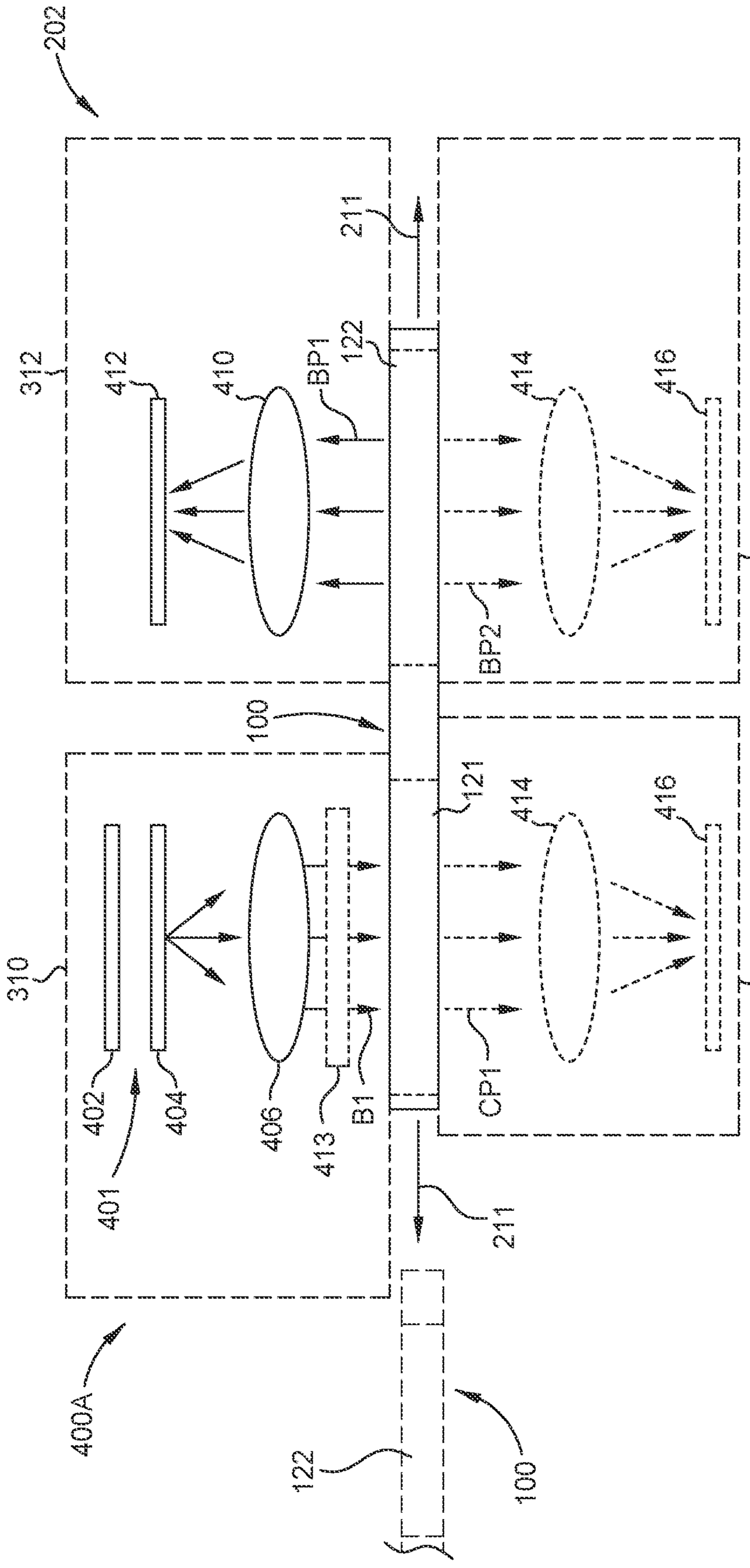

400A
401
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310
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316
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FIG. 4A

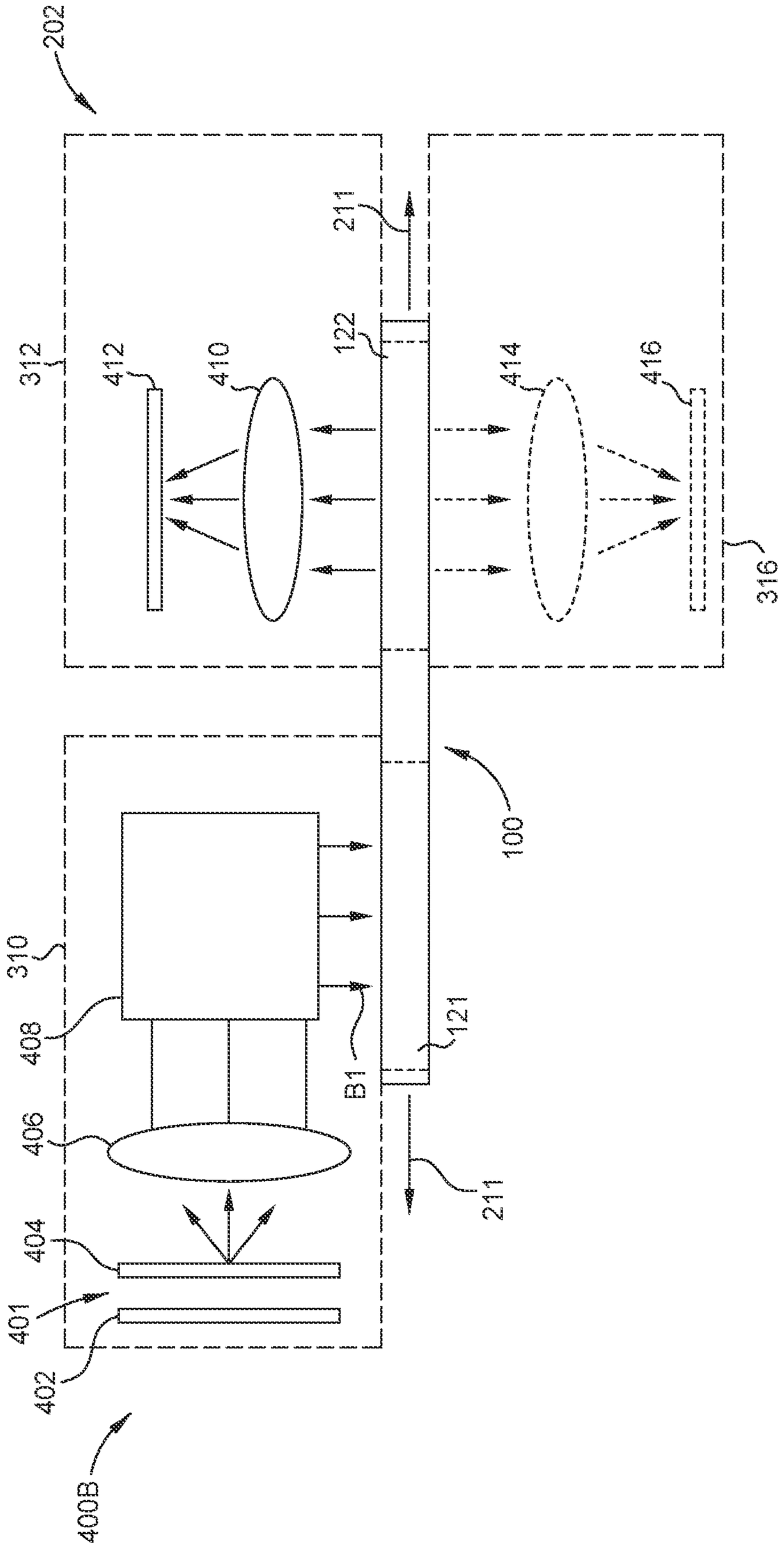

202
312
412
410
211
122
414
416
316
100
310
408
406
404
401
402
400B
121
B1

FIG. 4B

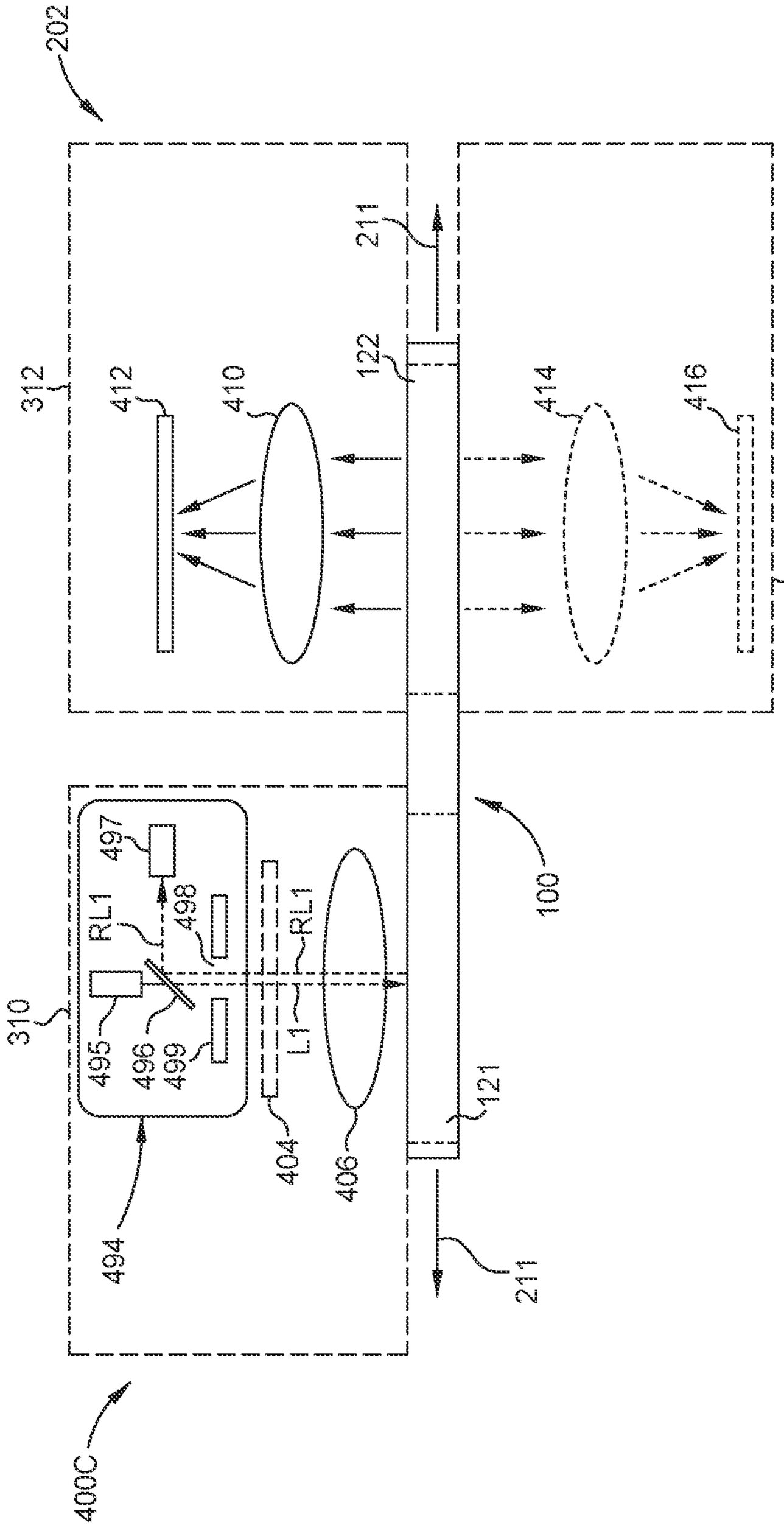

202
211
312
412
410
122
414
416
316
310
497
RL1
498
495
496
499
L1
RL1
100
121
494
404
406
211
400C

FIG. 4C

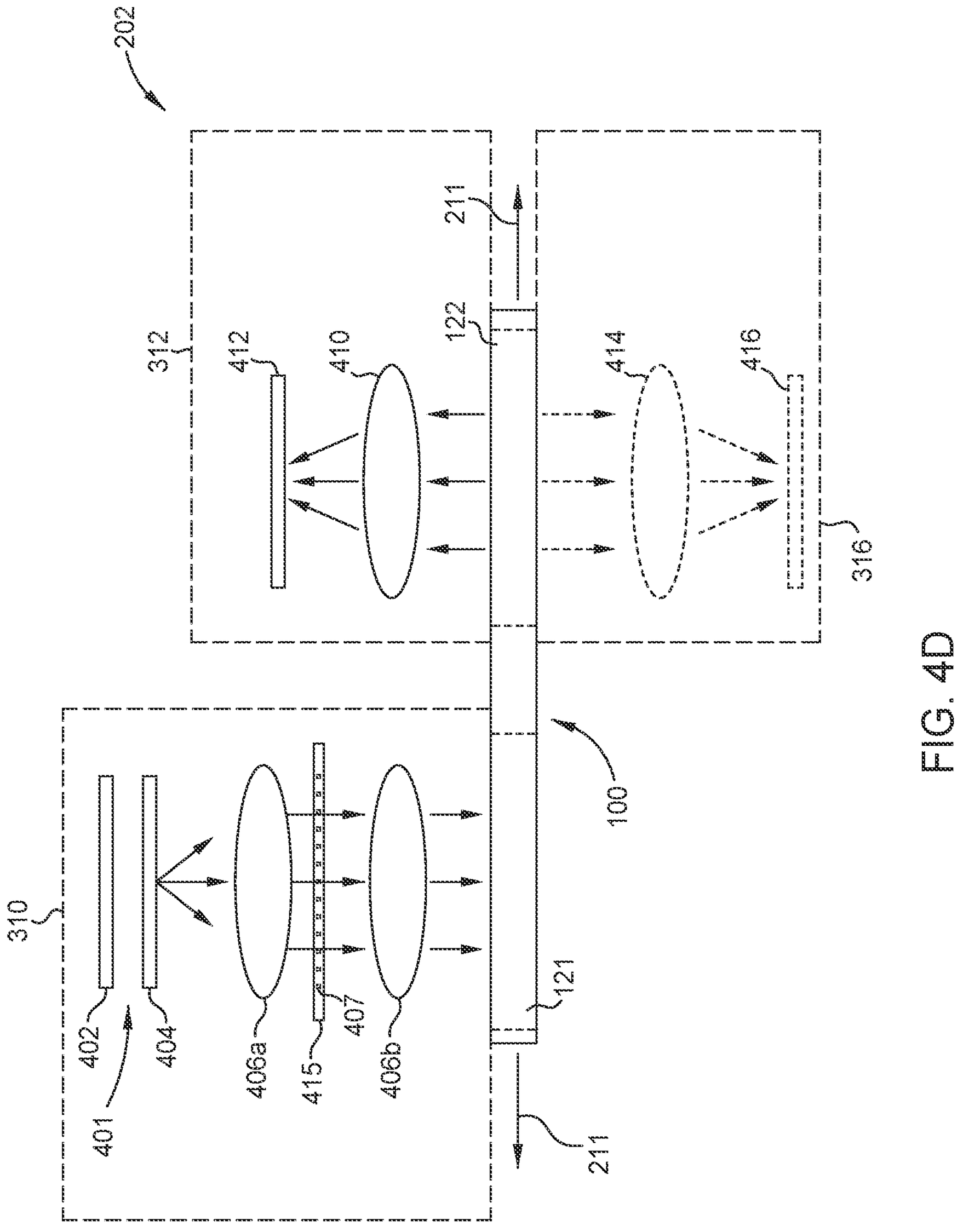

202
211
312
412
410
122
414
416
316
310
402
401
404
406a
415
407
406b
100
121
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400D

FIG. 4D

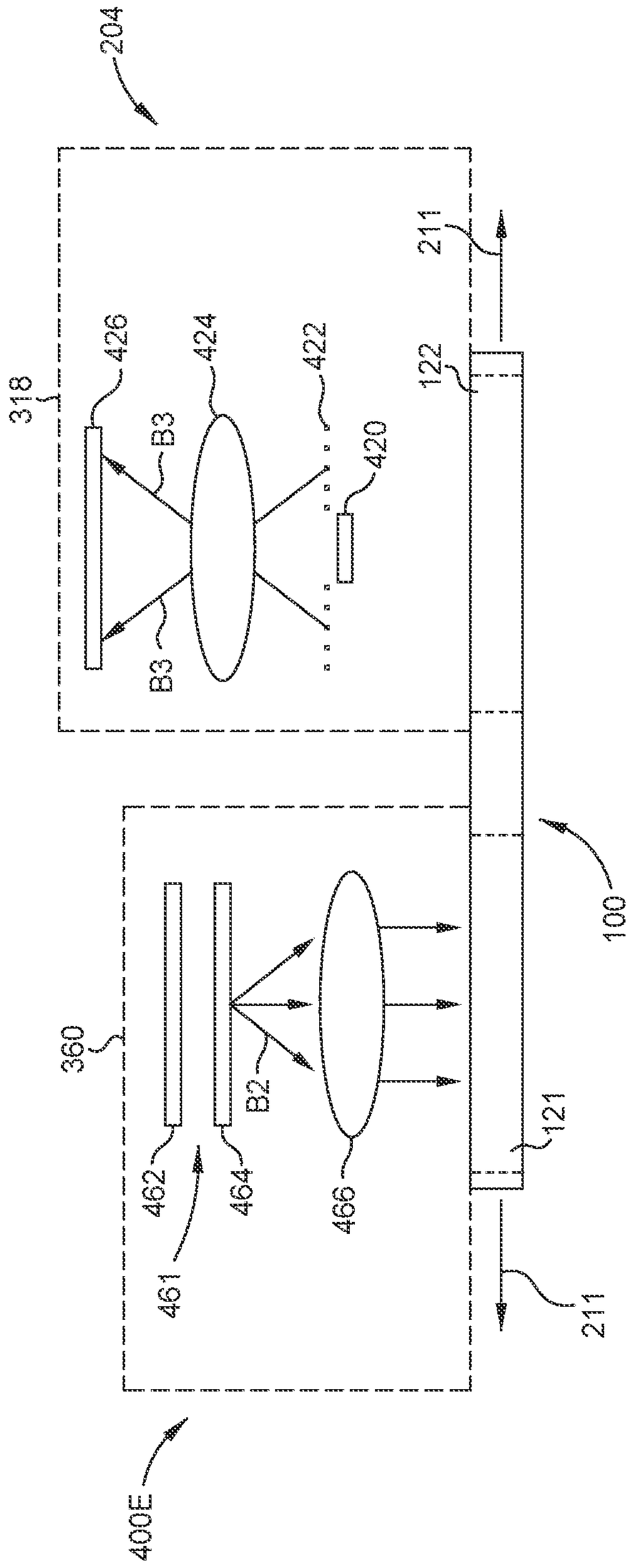

204
211
318
426
424
422
420
B3
B3
122
360
B2
462
464
466
461
100
121
211
400E

FIG. 4E

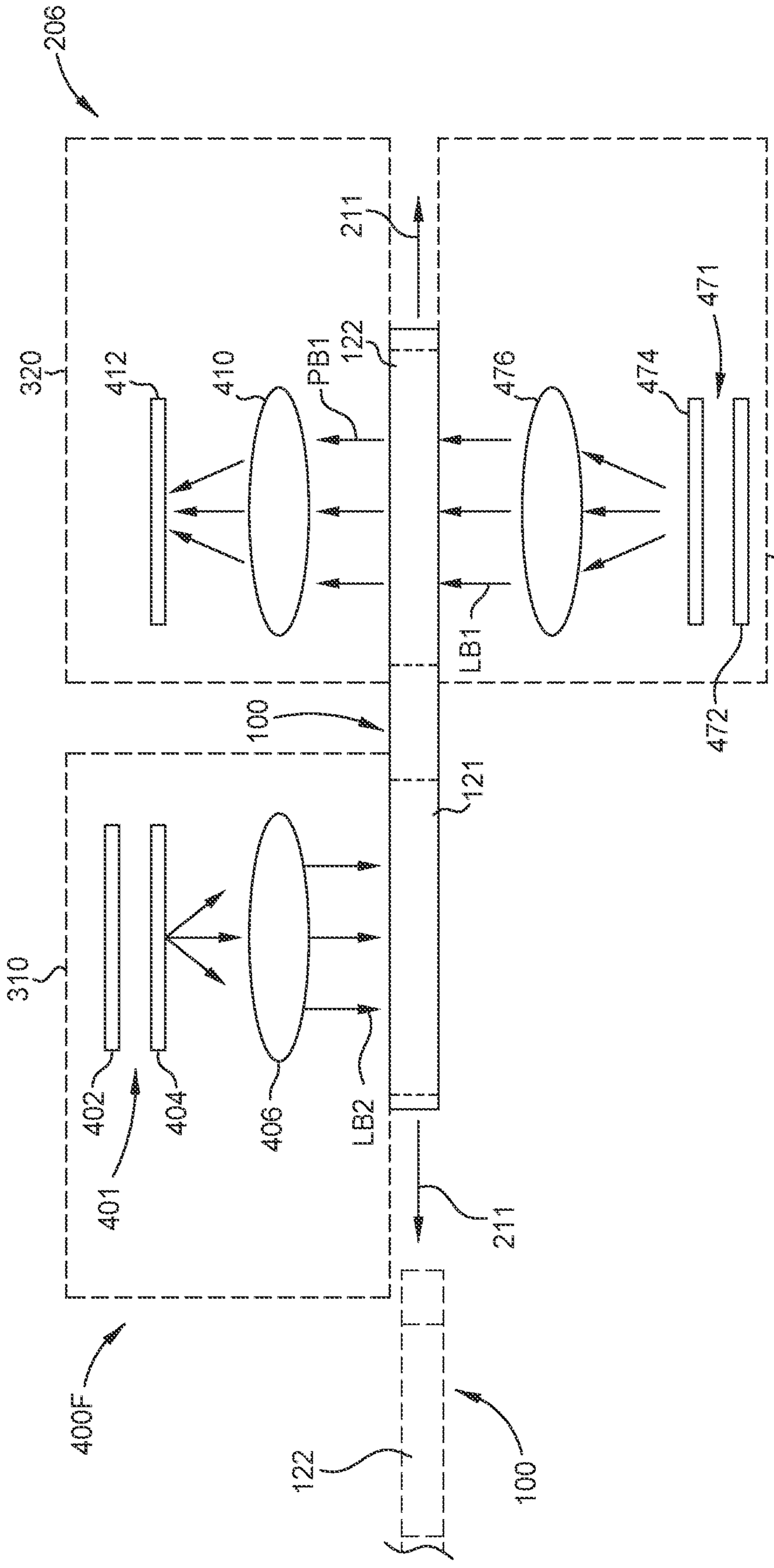

206
320
412
410
PB1
122
211
471
476
474
LB1
316
472
100
121
310
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404
406
LB2
401
400F
122
100

FIG. 4F

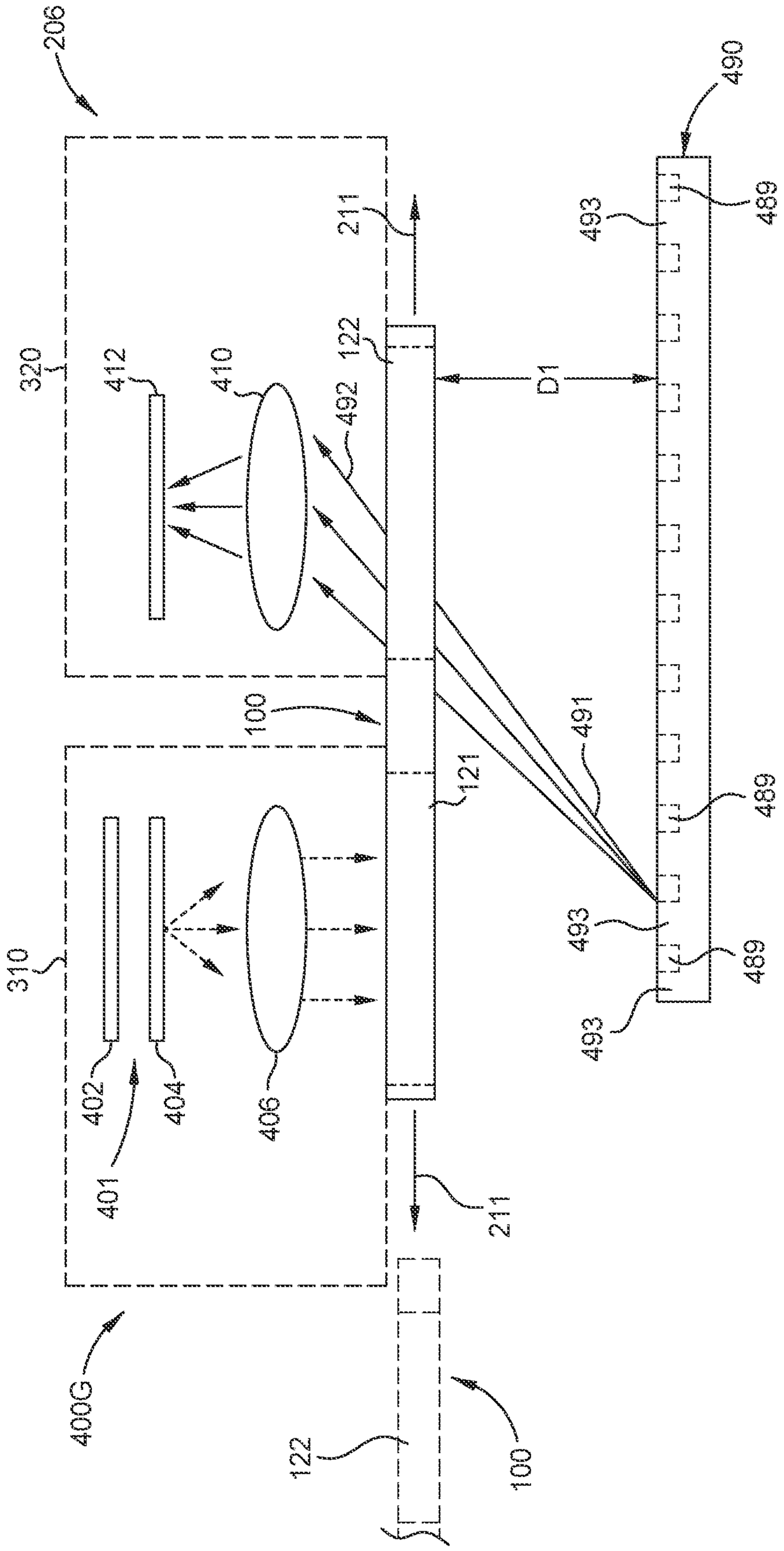

400G
401
402
404
406
310
320
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FIG. 4G

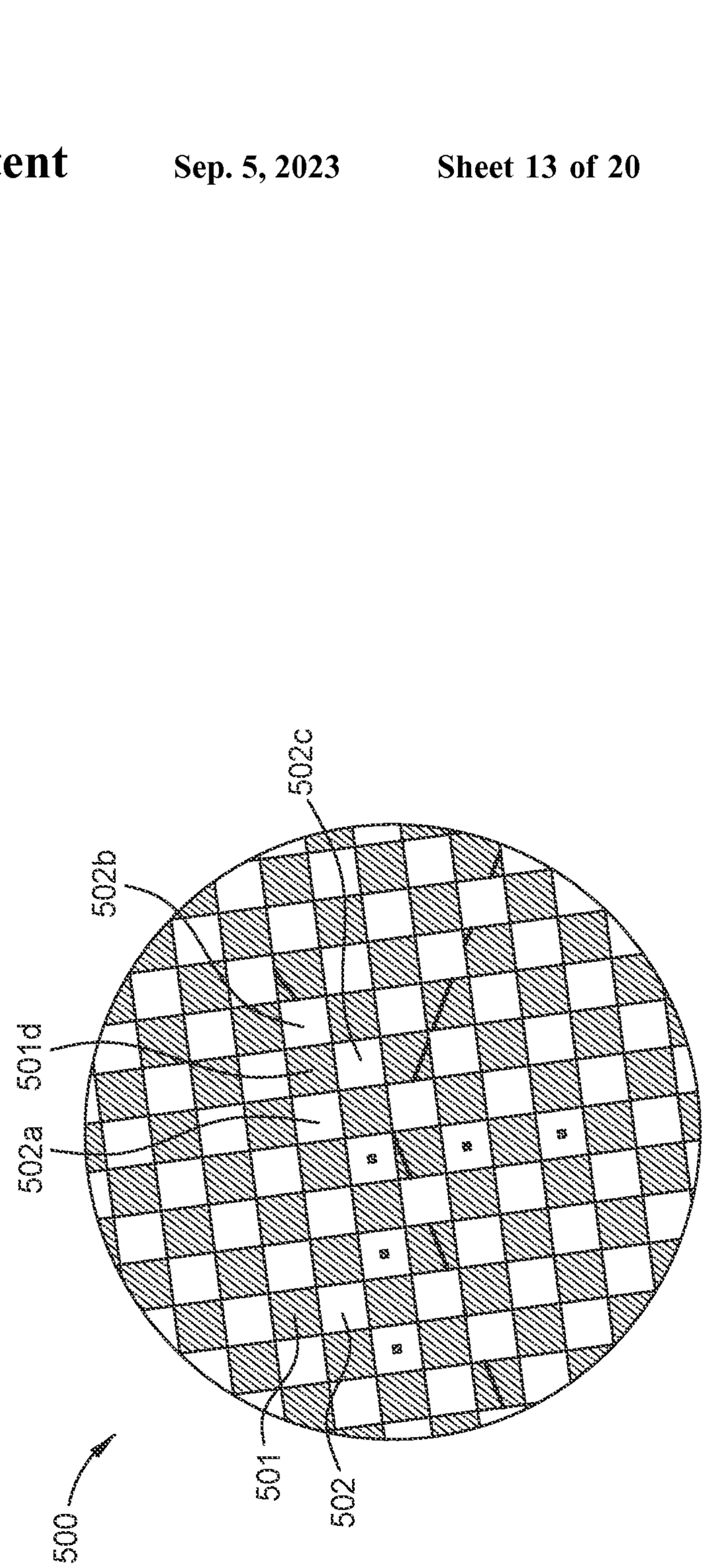


FIG. 5

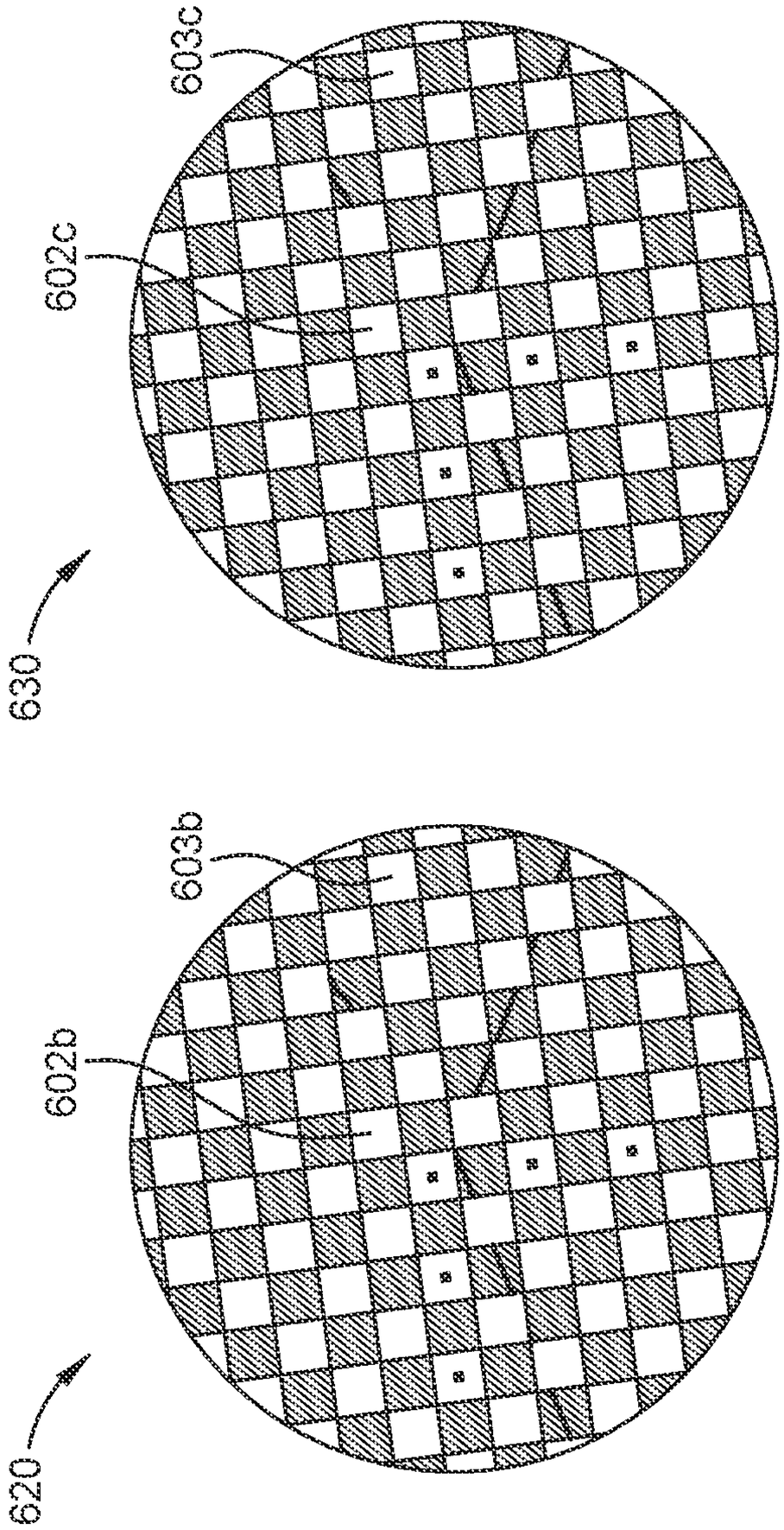


FIG. 6C

FIG. 6B

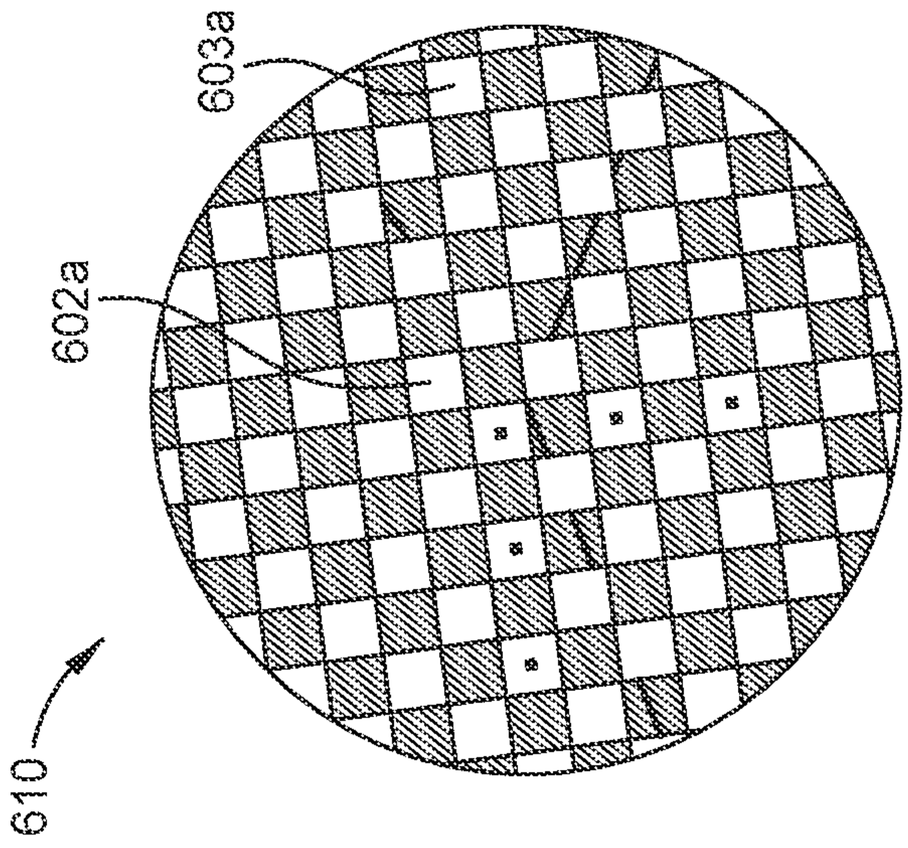


FIG. 6A

FIG. 7C

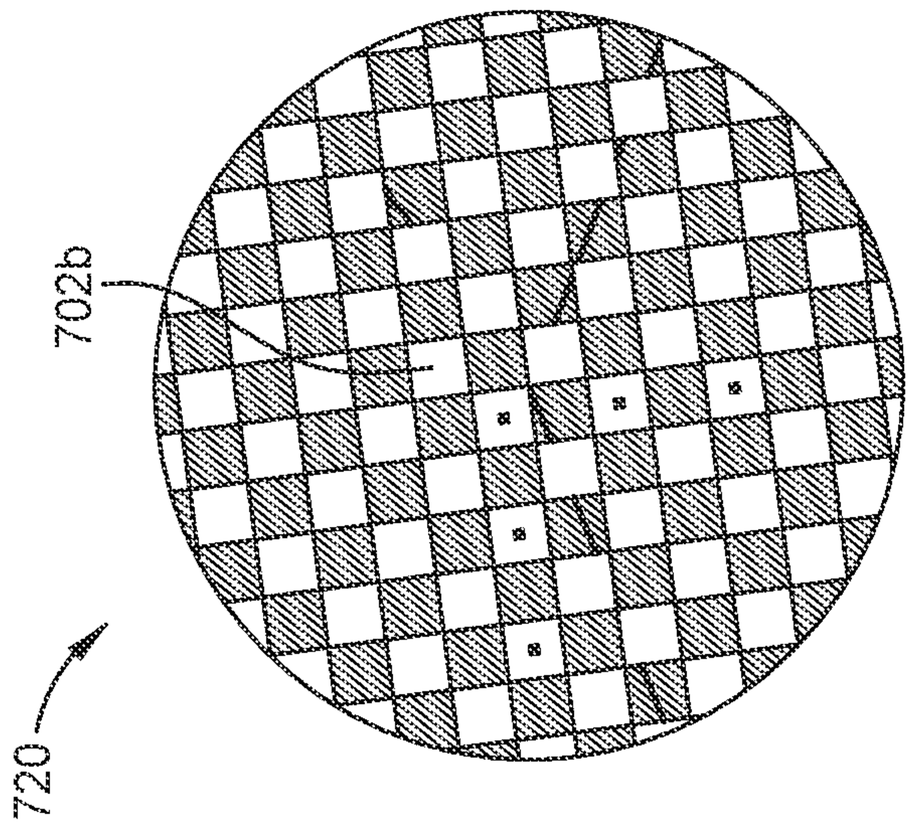


FIG. 7B

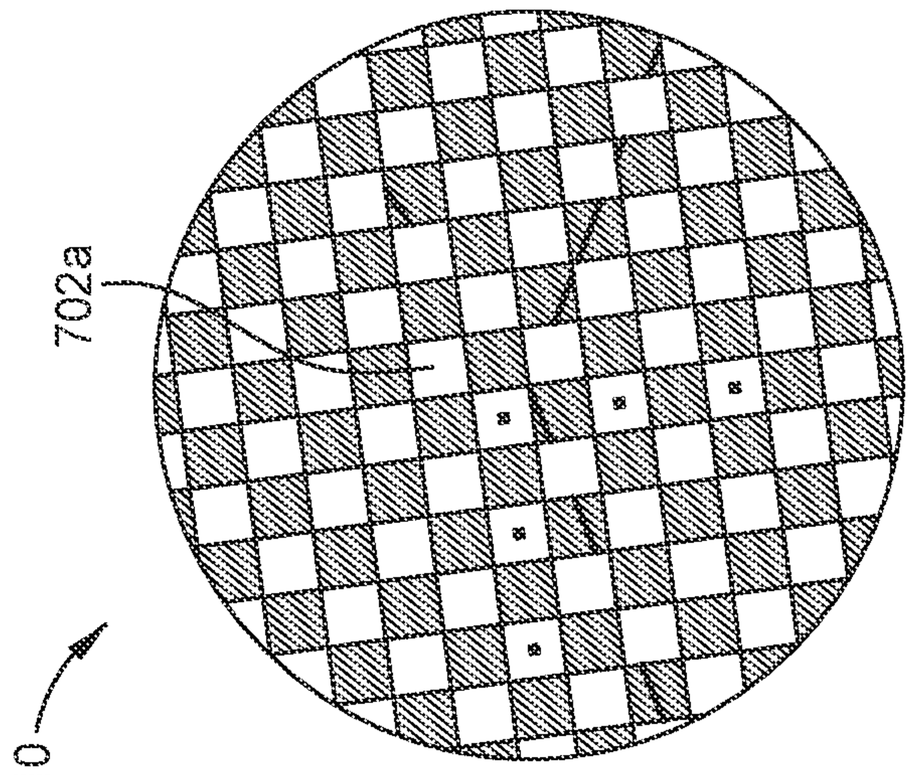


FIG. 7A

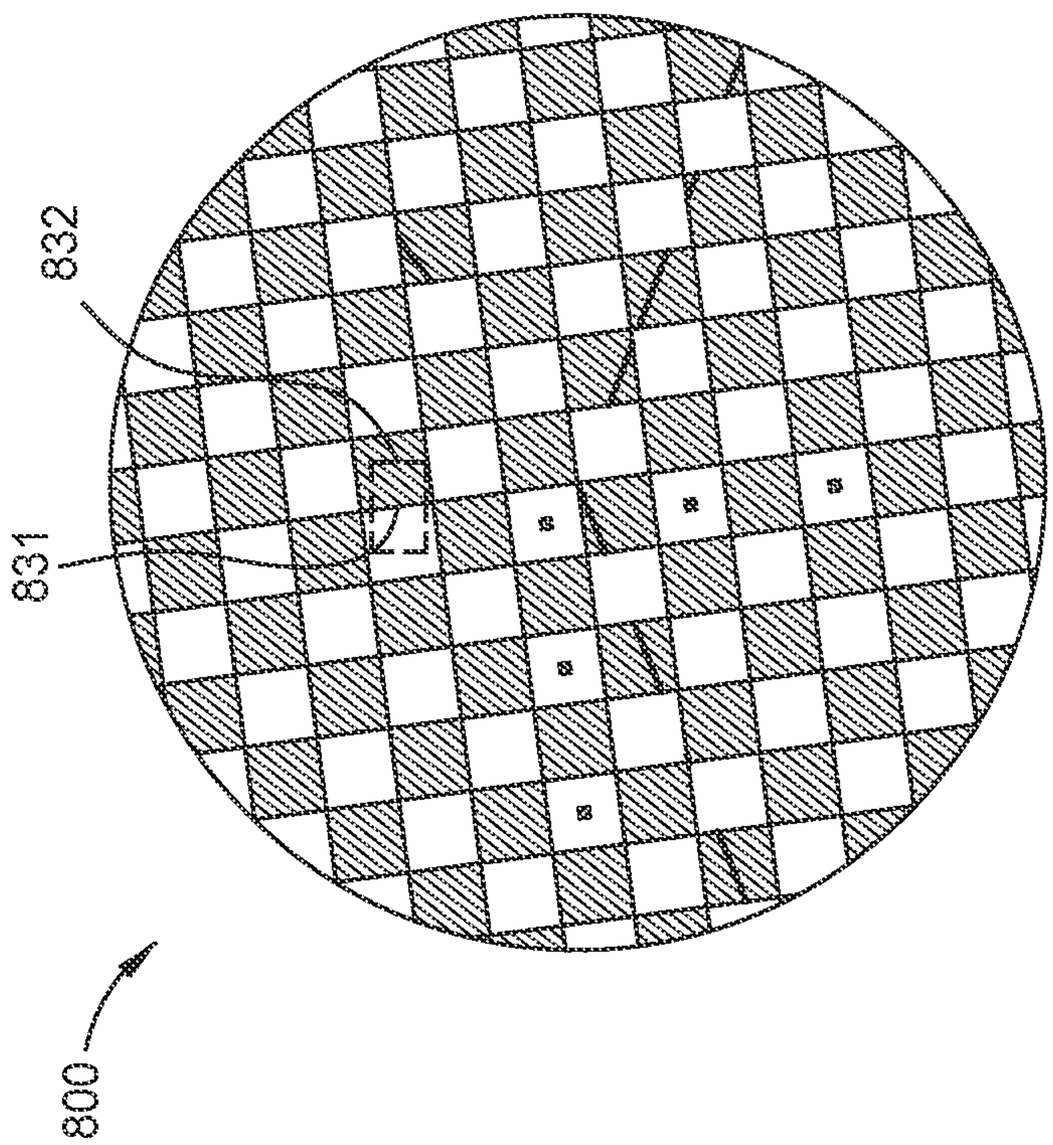


FIG. 8

FIG. 9C

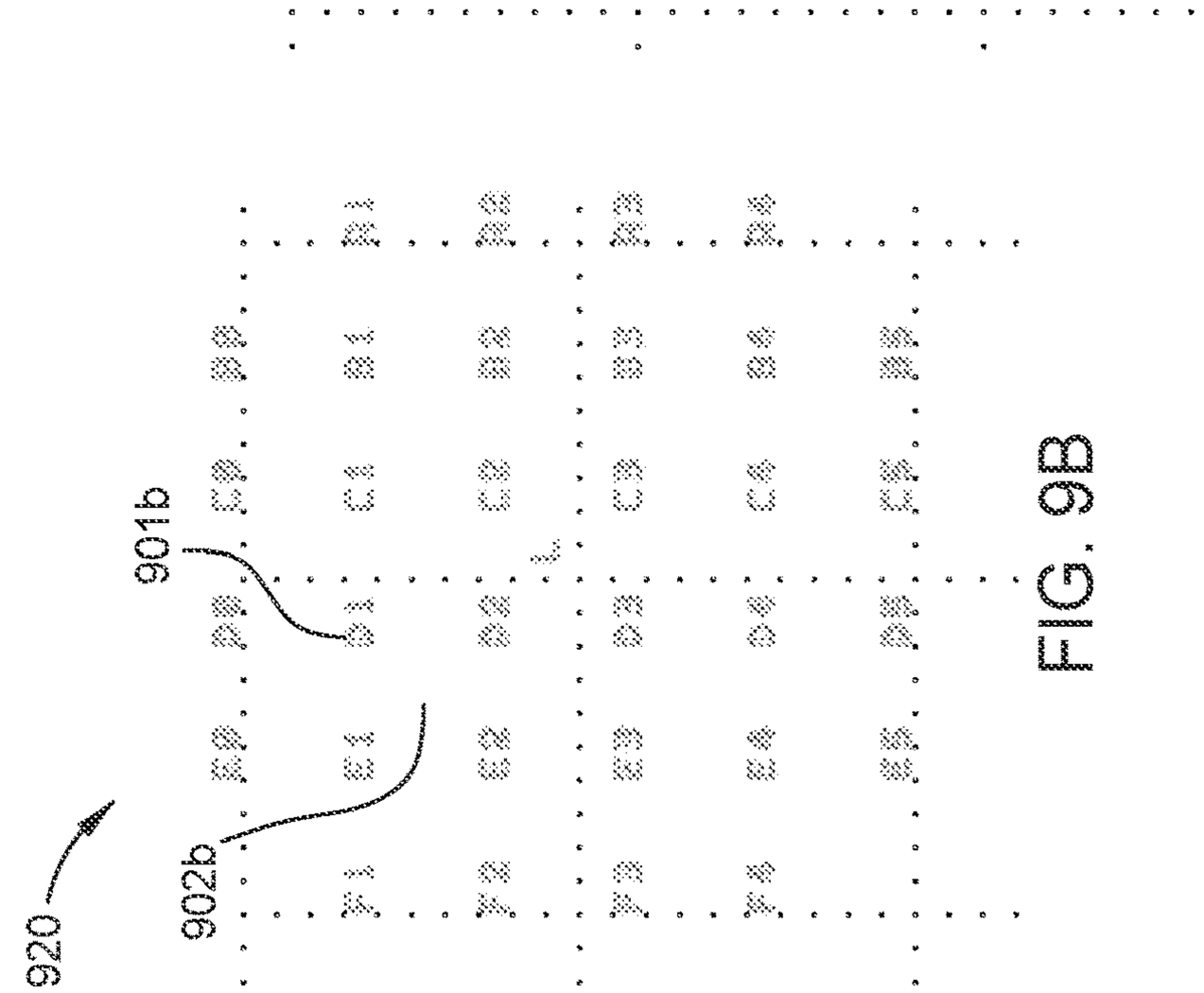


FIG. 9B

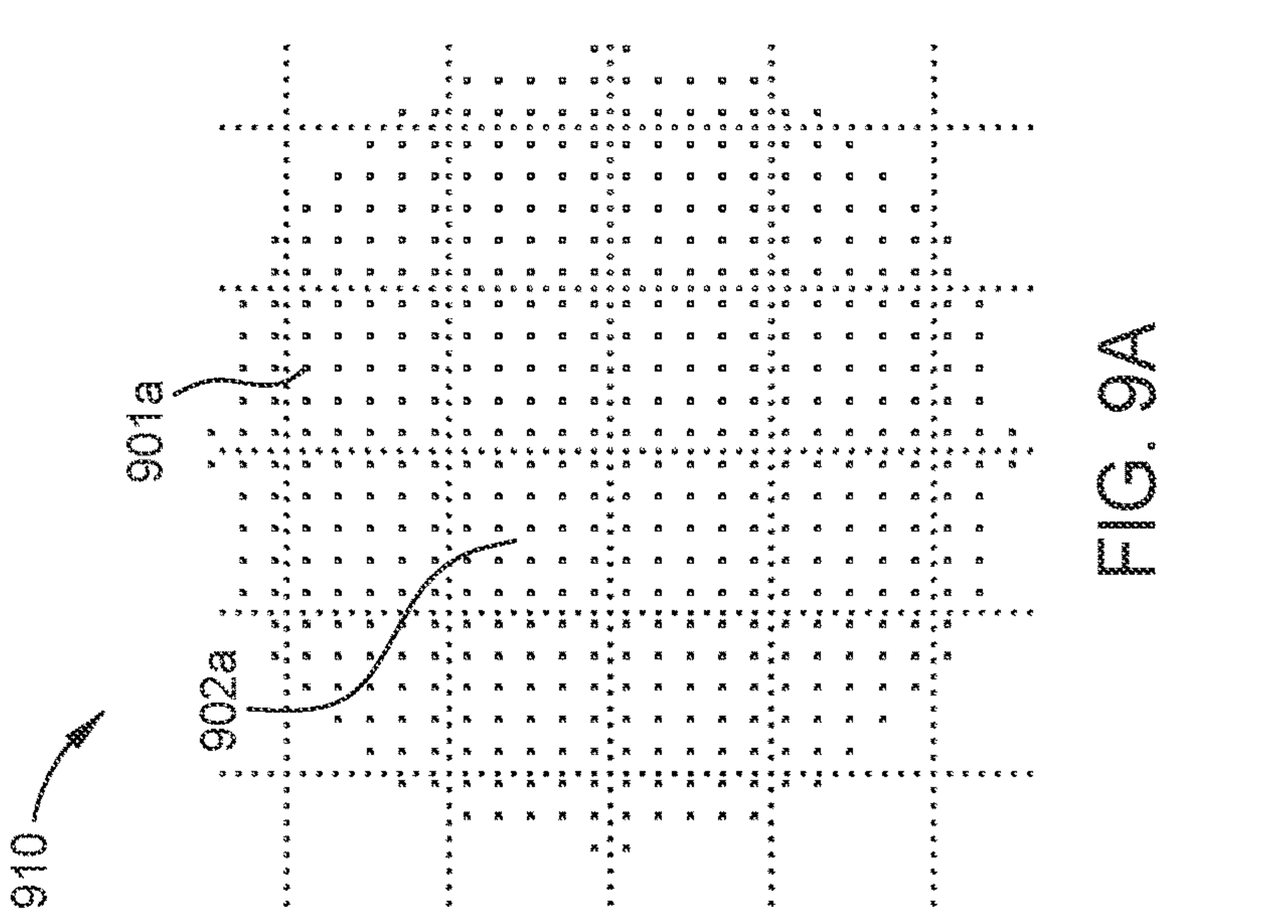


FIG. 9A

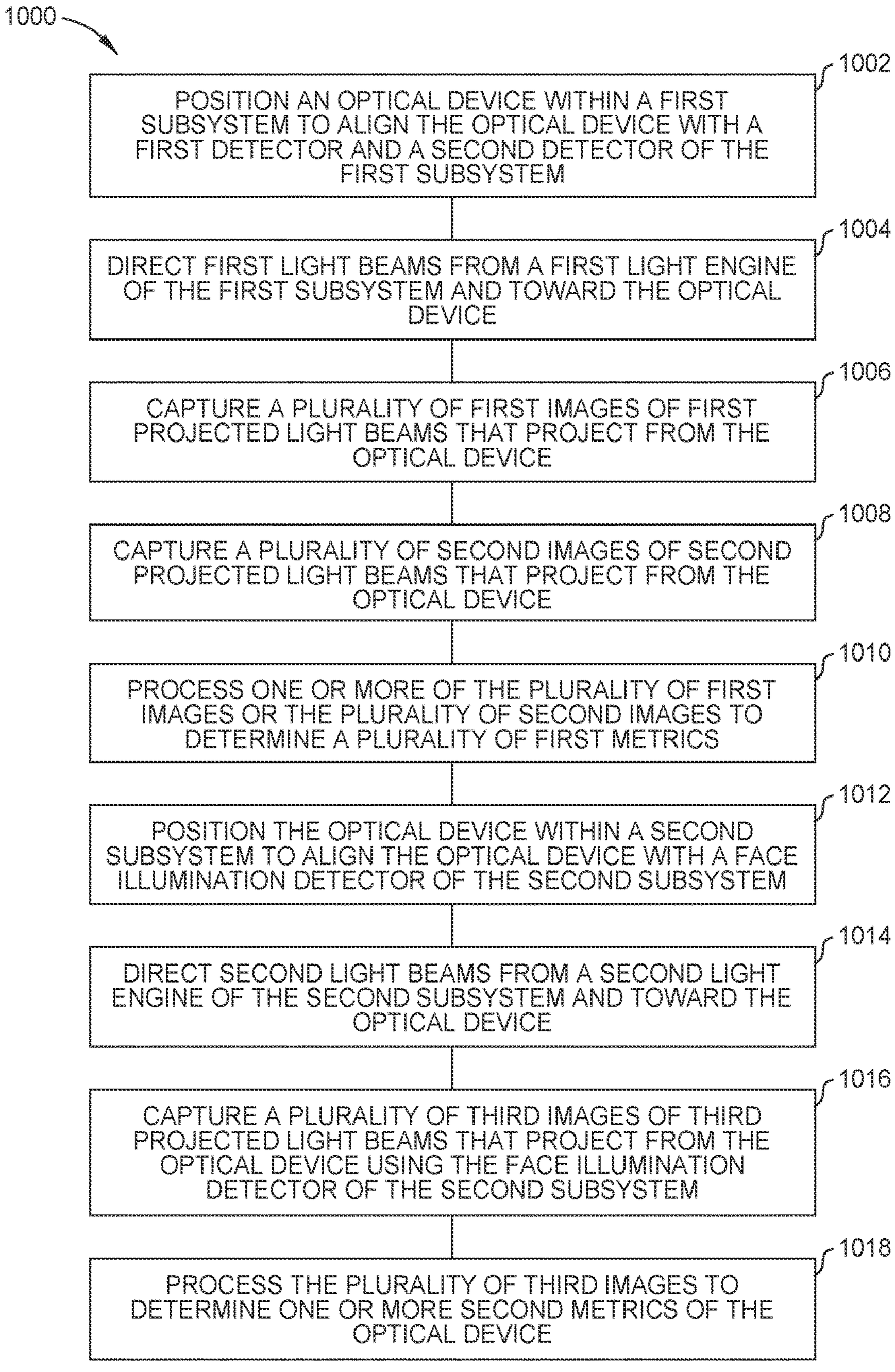

1000
1002
POSITION AN OPTICAL DEVICE WITHIN A FIRST SUBSYSTEM TO ALIGN THE OPTICAL DEVICE WITH A FIRST DETECTOR AND A SECOND DETECTOR OF THE FIRST SUBSYSTEM
1004
DIRECT FIRST LIGHT BEAMS FROM A FIRST LIGHT ENGINE OF THE FIRST SUBSYSTEM AND TOWARD THE OPTICAL DEVICE
1006
CAPTURE A PLURALITY OF FIRST IMAGES OF FIRST PROJECTED LIGHT BEAMS THAT PROJECT FROM THE OPTICAL DEVICE
1008
CAPTURE A PLURALITY OF SECOND IMAGES OF SECOND PROJECTED LIGHT BEAMS THAT PROJECT FROM THE OPTICAL DEVICE
1010
PROCESS ONE OR MORE OF THE PLURALITY OF FIRST IMAGES OR THE PLURALITY OF SECOND IMAGES TO DETERMINE A PLURALITY OF FIRST METRICS
1012
POSITION THE OPTICAL DEVICE WITHIN A SECOND SUBSYSTEM TO ALIGN THE OPTICAL DEVICE WITH A FACE ILLUMINATION DETECTOR OF THE SECOND SUBSYSTEM
1014
DIRECT SECOND LIGHT BEAMS FROM A SECOND LIGHT ENGINE OF THE SECOND SUBSYSTEM AND TOWARD THE OPTICAL DEVICE
1016
CAPTURE A PLURALITY OF THIRD IMAGES OF THIRD PROJECTED LIGHT BEAMS THAT PROJECT FROM THE OPTICAL DEVICE USING THE FACE ILLUMINATION DETECTOR OF THE SECOND SUBSYSTEM
1018
PROCESS THE PLURALITY OF THIRD IMAGES TO DETERMINE ONE OR MORE SECOND METRICS OF THE OPTICAL DEVICE

FIG. 10

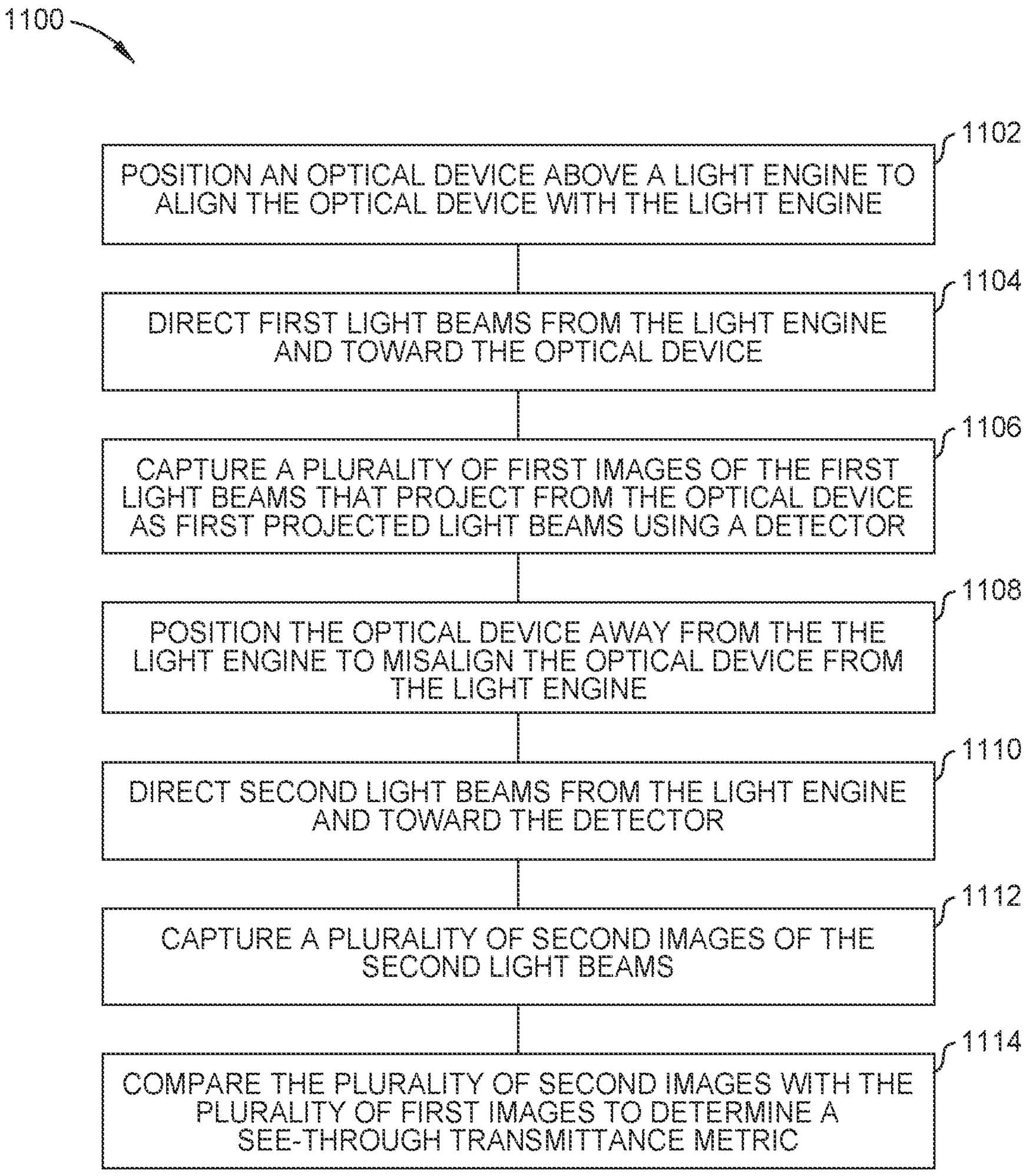

1100
POSITION AN OPTICAL DEVICE ABOVE A LIGHT ENGINE TO ALIGN THE OPTICAL DEVICE WITH THE LIGHT ENGINE
1102
DIRECT FIRST LIGHT BEAMS FROM THE LIGHT ENGINE AND TOWARD THE OPTICAL DEVICE
1104
CAPTURE A PLURALITY OF FIRST IMAGES OF THE FIRST LIGHT BEAMS THAT PROJECT FROM THE OPTICAL DEVICE AS FIRST PROJECTED LIGHT BEAMS USING A DETECTOR
1106
POSITION THE OPTICAL DEVICE AWAY FROM THE THE LIGHT ENGINE TO MISALIGN THE OPTICAL DEVICE FROM THE LIGHT ENGINE
1108
DIRECT SECOND LIGHT BEAMS FROM THE LIGHT ENGINE AND TOWARD THE DETECTOR
1110
CAPTURE A PLURALITY OF SECOND IMAGES OF THE SECOND LIGHT BEAMS
1112
COMPARE THE PLURALITY OF SECOND IMAGES WITH THE PLURALITY OF FIRST IMAGES TO DETERMINE A SEE-THROUGH TRANSMITTANCE METRIC
1114

FIG. 11

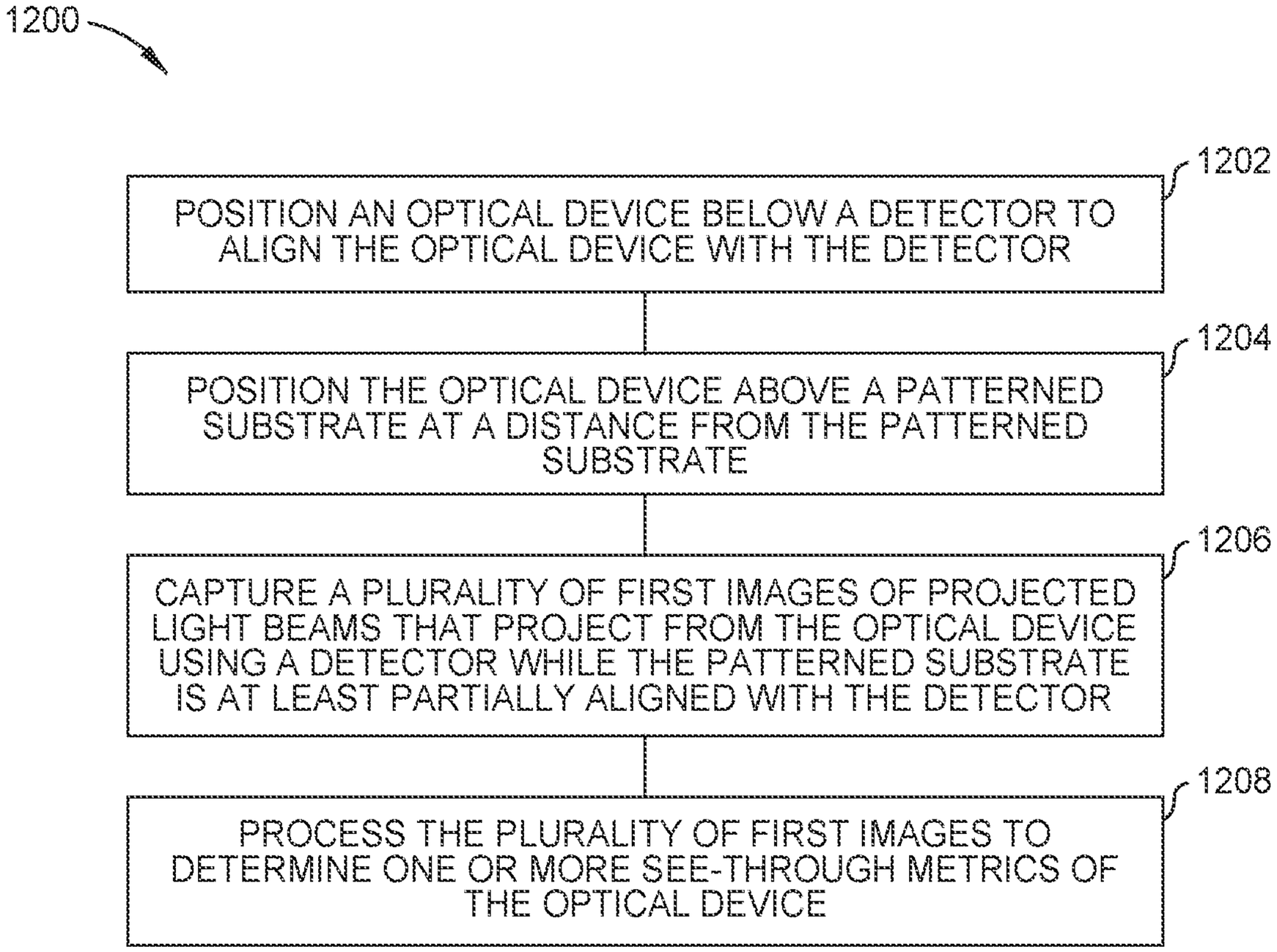

1200
POSITION AN OPTICAL DEVICE BELOW A DETECTOR TO ALIGN THE OPTICAL DEVICE WITH THE DETECTOR
1202
POSITION THE OPTICAL DEVICE ABOVE A PATTERNED SUBSTRATE AT A DISTANCE FROM THE PATTERNED SUBSTRATE
1204
CAPTURE A PLURALITY OF FIRST IMAGES OF PROJECTED LIGHT BEAMS THAT PROJECT FROM THE OPTICAL DEVICE USING A DETECTOR WHILE THE PATTERNED SUBSTRATE IS AT LEAST PARTIALLY ALIGNED WITH THE DETECTOR
1206
PROCESS THE PLURALITY OF FIRST IMAGES TO DETERMINE ONE OR MORE SEE-THROUGH METRICS OF THE OPTICAL DEVICE
1208

FIG. 12

SEE-THROUGH METROLOGY SYSTEMS, APPARATUS, AND METHODS FOR OPTICAL DEVICES

CROSS-REFERENCE TO RELATED APPLICATIONS

This application claims benefit of U.S. provisional patent application Ser. No. 63/092,421, filed Oct. 15, 2020, which is herein incorporated by reference in its entirety.

BACKGROUND

Field

Embodiments of the present disclosure relate to optical devices for augmented, virtual, and/or mixed reality applications. In one or more embodiments, an optical device metrology system is configured to measure a plurality of see-through metrics for optical devices.

Description of the Related Art

Virtual reality is generally considered to be a computer generated simulated environment in which a user has an apparent physical presence. A virtual reality experience can be generated in 3D and viewed with a head-mounted display (HMD), such as glasses or other wearable display devices that have near-eye display panels as lenses to display a virtual reality environment that replaces an actual environment.

Augmented reality, however, enables an experience in which a user can still see through the display lenses of the glasses or other HMD device to view the surrounding environment, yet also see images of virtual objects that are generated for display and appear as part of the environment. Augmented reality can include any type of input, such as audio and haptic inputs, as well as virtual images, graphics, and video that enhances or augments the environment that the user experiences. As an emerging technology, there are many challenges and design constraints with augmented reality.

One such challenge is displaying a virtual image overlaid on an ambient environment. Augmented waveguide combiners are used to assist in overlaying images. Generated light is in-coupled into an augmented waveguide combiner, propagated through the augmented waveguide combiner, out-coupled from the augmented waveguide combiner, and overlaid on the ambient environment. Light is coupled into and out of augmented waveguide combiners using surface relief gratings. The intensity of the out-coupled light may not be adequately controlled.

Accordingly, there is a need in the art for optical device metrology systems and methods.

SUMMARY

Embodiments of the present disclosure relate to optical devices for augmented, virtual, and/or mixed reality applications. In one or more embodiments, an optical device metrology system is configured to measure a plurality of see-through metrics for optical devices.

In one implementation, an optical device metrology system includes a stage configured to move a tray along a stage path, a first light engine mounted above the stage path and configured to direct upper light beams toward the stage path, and a second light engine mounted below the stage path and configured to direct lower light beams toward the stage path. The optical device metrology system includes a detector mounted above the stage path and configured to receive projected light beams projected from the stage path, and a controller in communication with the stage, the first light engine, the second light engine, and the detector. The controller includes instructions that, when executed, cause the stage to position an optical device above the second light engine to align the optical device with the second light engine, and the second light engine to direct first light beams from the second light engine and toward the optical device. The instructions also cause the detector to capture a plurality of first images of the first light beams that project from the optical device as first projected light beams, and the stage to position the optical device away from the second light engine to misalign the optical device from the second light engine. The instructions also cause the second light engine to direct second light beams from the second light engine and toward the detector, the detector to capture a plurality of second images of the second light beams, and comparing of the plurality of second images with the plurality of first images to determine a see-through transmittance metric of the optical device.

In one implementation, an optical device metrology system includes a stage configured to move a tray along a stage path, and a first light engine mounted above the stage path and configured to direct upper light beams toward the stage path. The optical device metrology system includes a second light engine mounted below the stage path and configured to direct lower light beams toward the stage path, and a detector mounted above the stage path and configured to receive projected light beams projected from the stage path. The detector is aligned with the second light engine and misaligned from the first light engine.

In one implementation, a method of analyzing optical devices includes positioning an optical device above a light engine to align the optical device with the light engine, and directing first light beams from the light engine and toward the optical device. The method includes capturing a plurality of first images of the first light beams that project from the optical device as first projected light beams using a detector, and positioning the optical device away from the light engine to misalign the optical device from the light engine. The method includes directing second light beams from the light engine and toward the detector, capturing a plurality of second images of the second light beams, and comparing the plurality of second images with the plurality of first images to determine a see-through transmittance metric of the optical device.

BRIEF DESCRIPTION OF THE DRAWINGS

So that the manner in which the above recited features of the present disclosure can be understood in detail, a more particular description of the disclosure, briefly summarized above, may be had by reference to embodiments, some of which are illustrated in the appended drawings. It is to be noted, however, that the appended drawings illustrate only exemplary embodiments and are therefore not to be considered limiting of its scope, and may admit to other equally effective embodiments.

FIG. **1**A is a perspective, frontal view of a substrate, according to one implementation.

FIG. **1**B is a perspective, frontal view of an optical device, according to one implementation.

FIG. **2** is a schematic view of an optical device metrology system, according to one implementation.

FIG. **3**A is a schematic partial cross-sectional view of the first subsystem shown in FIG. **2**, according to one implementation.

FIG. **3**B is a schematic partial cross-sectional view of the second subsystem shown in FIG. **2**, according to one implementation.

FIG. **3**C is a schematic partial cross-sectional view of the third subsystem shown in FIG. **2**, according to one implementation.

FIG. **4**A is a schematic view of a configuration of the first subsystem shown in FIGS. **2** and **3**A, according to one implementation.

FIG. **4**B is a schematic view of a configuration of the first subsystem shown in FIGS. **2** and **3**A, according to one implementation.

FIG. **4**C is a schematic view of a configuration of the first subsystem shown in FIGS. **2** and **3**A, according to one implementation.

FIG. **4**D is a schematic view of a configuration of the first subsystem shown in FIGS. **2** and **3**A, according to one implementation.

FIG. **4**E is a schematic view of a configuration of the second subsystem shown in FIGS. **2** and **3**B, according to one implementation.

FIG. **4**F is a schematic view of a configuration of the third subsystem shown in FIGS. **2** and **3**C, according to one implementation.

FIG. **4**G is a schematic view of a configuration of the third subsystem shown in FIGS. **2** and **3**C, according to one implementation.

FIG. **5** is a schematic view of an image, according to one implementation.

FIGS. **6**A-**6**C are schematic views of images, according to one implementation.

FIGS. **7**A-**7**C are schematic views of images, according to one implementation.

FIG. **8** is a schematic view of an image, according to one implementation.

FIGS. **9**A-**9**C are schematic views of images, according to one implementation.

FIG. **10** is a schematic block diagram view of a method of analyzing optical devices, according to one implementation.

FIG. **11** is a schematic block diagram view of a method of analyzing optical devices, according to one implementation.

FIG. **12** is a schematic block diagram view of a method of analyzing optical devices, according to one implementation.

To facilitate understanding, identical reference numerals have been used, where possible, to designate identical elements that are common to the figures. It is contemplated that elements and features of one embodiment may be beneficially incorporated in other embodiments without further recitation.

DETAILED DESCRIPTION

Embodiments of the present disclosure relate to optical devices for augmented, virtual, and/or mixed reality applications. In one or more embodiments, an optical device metrology system is configured to measure a plurality of see-through metrics for optical devices.

FIG. **1**A is a perspective, frontal view of a substrate **101**, according to one implementation. The substrate includes a plurality of optical devices **100** disposed on a surface **103** of the substrate **101**. The optical devices **100** are waveguide combiners utilized for virtual, augmented, and/or mixed reality. The optical devices **100** may be part of the substrate **101** such that the optical devices **100** can be cut to be separated from the substrate **101**.

FIG. **1**B is a perspective, frontal view of an optical device **100**, according to one implementation. It is to be understood that the optical devices **100** described herein are exemplary optical devices and that other optical devices (such as optical devices other than waveguide combiners) may be used with or modified to accomplish aspects of the present disclosure.

The optical device **100** includes a plurality of optical device structures **102** disposed on a surface **103** of a substrate **101**. The optical device structures **102** may be nano-structures having sub-micron dimensions (e.g., nano-sized dimensions). Regions of the optical device structures **102** correspond to one or more gratings **104**, such as a first grating **104***a*, a second grating **104***b*, and a third grating **104***c*. In one embodiment, which can be combined with other embodiments, the optical device **100** includes at least the first grating **104***a* corresponding to an input coupling grating and the third grating **104***c* corresponding to an output coupling grating. In one embodiment, which can be combined with other embodiments described herein, the optical device **100** also includes the second grating **104***b* corresponding to an intermediate grating. The optical device structures **102** may be angled or binary. The optical device structures **102** are rectangular. The optical device structures **102** may have other shapes including, but not limited to, circular, triangular, elliptical, regular polygonal, irregular polygonal, and/or irregular shaped cross-sections.

In operation (such as for augmented reality glasses), the input coupling grating **104***a* receives incident beams of light (a virtual image) having an intensity from a microdisplay. The incident beams are split by the optical device structures **102** into T**1** beams that have all of the intensity of the incident beams in order to direct the virtual image to the intermediate grating **104***b* (if utilized) or the output coupling grating **104***c*. In one embodiment, which can be combined with other embodiments, the T**1** beams undergo total-internal-reflection (TIR) through the optical device **100** until the T**1** beams come in contact with the optical device structures **102** of the intermediate grating **104***b*. The optical device structures **102** of the intermediate grating **104***b* diffract the T**1** beams to T−1 beams that undergo TIR through the optical device **100** to the optical device structures **102** of the output coupling grating **104***c*. The optical device structures **102** of the output coupling grating **104***c* outcouple the T−1 beams to the user's eye to modulate the field of view of the virtual image produced from the microdisplay from the user's perspective and further increase the viewing angle from which the user can view the virtual image. In one embodiment, which can be combined with other embodiments, the T**1** beams undergo total-internal-reflection (TIR) through the optical device **100** until the T**1** beams come in contact with the optical device structures **102** of the output coupling grating and are outcoupled to modulate the field of view of the virtual image produced from the microdisplay.

To facilitate ensuring that the optical devices **100** meet image quality standards, metrology metrics of the fabricated optical devices **100** are obtained prior to use of the optical devices **100**.

FIG. **2** is a schematic view of an optical device metrology system **200**, according to one implementation. Embodiments of the optical device metrology system **200** described herein provide for the ability to obtain multiple metrology metrics with increased throughput. The metrology metrics include an angular uniformity metric, a contrast metric, an efficiency metric, a color uniformity metric, a modulation transfer

function (MTF) metric, a field of view (FOV) metric, a ghost image metric, an eye box metric, a display leakage metric, a see-through distortion metric, a see-through flare metric, a see-through ghost image metric, and a see-through transmittance metric. The throughput is increased via the utilization of a feeding system coupled to each of one or more subsystems of the optical device metrology system **200**.

The optical device metrology system **200** includes a first subsystem **202**, a second subsystem **204**, and a third subsystem **206**. Each of the first subsystem **202**, the second subsystem **204**, and the third subsystem **206** include a respective body **201**A-**201**C with a first opening **203** and a second opening **205** to allow a stage **207** to move therethrough along a stage path **211** that is parallel to and/or in the X-Y plane. The stage **207** is operable to move in an X-direction, a Y-direction, and a Z-direction in the bodies **201**A-**201**C of the first subsystem **202**, the second subsystem **204**, and the third subsystem **206**. The stage **207** includes a tray **209** operable to retain the optical devices **100** (as shown herein) or one or more substrates **101**. The stage **207** and the tray **209** may be transparent such that the metrology metrics obtained by the first subsystem **202**, the second subsystem **204**, and the third subsystem **206** are not impacted by the translucence of the stage **207** of the tray **209**. The first subsystem **202**, the second subsystem **204**, and the third subsystem **206** are in communication with a controller **208** operable to control operation of the first subsystem **202**, the second subsystem **204**, and the third subsystem **206**. The controller **208** includes instructions stored in a non-transitory computer readable medium (such as a memory). The instructions, when executed by a processor of the controller **208**, cause operations described herein to be conducted. The instructions, when executed by the processor of the controller **208**, cause one or more operations of one or more of the methods **1000**, **1100**, and/or **1200** to be conducted.

The instructions of the controller **208** include a machine learning algorithm and/or an artificial intelligence algorithm to optimize operations. In one embodiment, which can be combined with other embodiments, the instructions of the controller **208** include a machine learning (ML) model that is a regression model and averages data (such as metrics determined herein and/or image data collected using the alignment module **494**). In one example, which can be combined with other examples, the ML model is used to average and merge data to determine optimized pitches and tilts for projection structures, lenses, and cameras. In one example, which can be combined with other examples, the ML model is used to average and merge data to determine optimized powers to apply to light sources and laser sources to generate light beams and laser beams.

The first subsystem **202** is operable to obtain one or more metrology metrics including the angular uniformity metric, the contrast metric, the efficiency metric, the color uniformity metric, the MTF metric, the FOV metric, the ghost image metric, or the eye box metric. The second subsystem **204** is operable to obtain the display leakage metric. The third subsystem **206** is operable to obtain one or more see-through metrology metrics including the see-through distortion metric, the see-through flare metric, the see-through ghost image metric, or the see-through transmittance metric.

The optical device metrology system **200** is configured to determine a display leakage metric, one or more see-through metrics, and one or more other metrology metrics for a plurality of optical devices (such as waveguide combiners) on a single system using a single stage path **211**.

FIG. **3**A is a schematic partial cross-sectional view of the first subsystem **202** shown in FIG. **2**, according to one implementation. The first subsystem **202** may include one or more of configurations **400**A, **400**B, **400**C, **400**D shown in FIGS. **4**A-**4**D.

As shown in FIG. **3**A, the first subsystem **202** includes an upper portion **304** oriented toward a top side of the optical devices **100** and a lower portion **306** oriented toward a bottom side of the optical device **100**.

The first subsystem **202** includes a first body **201**A having a first opening **203** and a second opening **205** to allow the stage **207** to move through the first opening **203** and the second opening **205**. The stage **207** is configured to move the tray **209** along the stage path **211**. The first subsystem **202** includes a first light engine **310** positioned within the first body **201**A and mounted above the stage path **211**. The first light engine **310** is an upper light engine. The first light engine **310** configured to direct first light beams toward the stage path **211**. In one embodiment, which can be combined with other embodiments, the first light beams are directed in a light pattern design toward the stage path **211** and toward one of the optical devices **100** for determination of metrology metrics. The first subsystem **202** includes a first detector **312** positioned within the first body **201**A and mounted above the stage path **211** to receive first projected light beams projected upwardly from the stage path **211**. The present disclosure contemplates that projected light can be light that is reflected from an optical device or transmitted through an optical device. The first detector **312** is a reflection detector. The first subsystem **202** includes a second detector **316** positioned within the first body **201**A and mounted below the stage path **211** to receive second projected light beams projected downwardly from the stage path **211**. The second detector **316** is a transmission detector. The first projected light beams and the second projected light beams are projected from an optical device **100**. In one embodiment, which can be combined with other embodiments, the first light engine **310** is configured to direct the first light beams toward the input coupling grating of an optical device **100**, and the first and second detectors **312**, **316** are configured to receive projected light beams that project from the output coupling grating of the optical device **100**.

The upper portion **304** of the first subsystem **202** includes an alignment detector **308**. The alignment detector **308** includes a camera. The alignment detector **308** is operable to determine a position of the stage **207** and the optical devices **100**. The lower portion **306** of the first subsystem **202** includes a code reader **314** mounted below the stage path **211**. The code reader **314** is operable to read a code of the optical devices **100**, such as a quick response (QR) code or barcode of an optical device **100**. The code read by the code reader **314** may include instructions for obtaining one or more metrology metrics for various optical devices **100**.

FIG. **3**B is a schematic partial cross-sectional view of the second subsystem **204** shown in FIG. **2**, according to one implementation. The second subsystem **204** may include at least one configuration **400**E as shown in FIG. **4**E.

As shown in FIG. **3**B, the second subsystem **204** includes the upper portion **304** oriented toward a top side of the optical devices **100** and a lower portion oriented to toward a bottom side of the optical device **100**.

The second subsystem **204** includes a second body **201**B and a second light engine **360** positioned within the second body **201**B and mounted above the stage path **211**. The second light engine **360** configured to direct second light

beams toward the stage path **211**. The upper portion **304** of the first subsystem **202** includes the alignment detector **308**.

The second subsystem **204** includes a face illumination detector **318** configured to receive third projected light beams projected upwardly from the stage path **211**. The third projected light beams are projected from an optical device **100**. The lower portion **306** of the second subsystem **204** includes the code reader **314**.

The face illumination detector **318** is operable to capture images to obtain the display leakage metric for the optical device **100**. In one embodiment, which can be combined with other embodiments, a light pattern design is directed from the second light engine **360** and toward the optical device **100**, and images of light outside a location of the user's eye are obtained and processed to obtain an eye box metric.

FIG. **3**C is a schematic partial cross-sectional view of the third subsystem **206** shown in FIG. **2**, according to one implementation. The third subsystem **206** may include one or more configurations **400**F and/or **400**G as shown in FIGS. **4**F and **4**G.

As shown in FIG. **3**C, the third subsystem **206** includes an upper portion **304** oriented toward a top side of the optical devices **100** and a lower portion **306** oriented toward a bottom side of the optical device **100**. The third subsystem **206** includes a first light engine **370** mounted above the stage path **211** and configured to direct upper light beams toward the stage path **211**, a second light engine **380** mounted below the stage path **211** and configured to direct lower light beams toward the stage path **211**, and a detector **390** mounted above the stage path and configured to receive projected light beams projected from the stage path **211**. The upper portion **304** of the third subsystem **206** includes the alignment detector **308**. The detector **390** is a reflection detector. The detector **390** detects projected (e.g., reflected) light beams that project (e.g., reflect) from the output coupling grating from the top side of the optical devices **100**. The lower portion **306** of the third subsystem **206** includes the code reader **314**. Each of the first light engine **370**, the second light engine **380**, and the detector **390** are positioned within a third body **201**C of the third subsystem **206**.

FIG. **4**A is a schematic view of a configuration **400**A of the first subsystem **202** shown in FIGS. **2** and **3**A, according to one implementation. The configuration **400**A includes the first light engine **310**, the first detector **312**, and the second detector **316**.

The first light engine **310** includes a first illuminator **401**, and the first illuminator **401** includes a first light source **402** and a first projection structure **404**. The first light engine **310** includes a first lens **406** positioned between the first illuminator **401** and the stage path **211**. The first light engine **310** includes one or more devices **413** (one is shown in FIG. **4**A) positioned between the first lens **406** and the stage path **211**. The one or more devices **413** includes one or more of a quarter wave plate or a linear polarizer. In one embodiment, which may be combined with other embodiments described herein, the first light engine **310** is configured to emit (e.g., project) light beams in a red spectrum, a green spectrum, and a blue spectrum. In one example, which can be combined with other examples, the first light engine **310** is configured to modulate or pulse light beams between the red spectrum, the green spectrum, and the blue spectrum. In one example, which can be combined with other examples, the first light engine **310** includes three light sources that are each configured to respectively emit light in the red spectrum, light in the green spectrum, and light in the blue spectrum.

The first projection structure **404** includes one or more of a display and/or a reticle. In one embodiment, which can be combined with other embodiments, the first projection structure **404** includes one or more of a microdisplay, a spatial light modulator (SLM), and/or a reticle. In one example, which can be combined with other examples, the SLM includes one or more of a digital micromirror device (DMD) and/or a liquid crystal on silicon (LCOS) emitter.

The first detector **312** includes a first camera **412** and a second lens **410** positioned between the first camera **412** and the stage path **211**. The second detector **316** includes a second camera **416** and a third lens **414** positioned between the second camera **416** and the stage path **211**. In the implementation shown in FIG. **4**A, the first projection structure **404** and the first lens **406** are oriented parallel to the stage path **211**.

The optical device **100** is positioned to align an input coupler **121** of the optical device **100** with the first light engine **310**, and to align an output coupler **122** of the optical device **100** with the first detector **312** and the second detector **316**. First light beams B**1** are directed from the first light engine **310** and toward the input coupler **121** of the optical device **100**. The first detector **312** captures a plurality of first images of first projected light beams BP**1** that project from the output coupler **122** in the red spectrum, the green spectrum, and the blue spectrum. The second detector **316** captures a plurality of second images of second projected light beams BP**2** that project from the output coupler **122** in the red spectrum, the green spectrum, and the blue spectrum.

The first images and the second images are full-field images. One or more of the first images and/or the second images are processed (such as by using the controller **208**) to determine a plurality of first metrics of the optical device **100**.

The plurality of first metrics include an angular uniformity metric. The angular uniformity metric can represent a ratio of light intensities across sections of light fields. For the angular uniformity metric, the processing of one or more of the plurality of first images or the plurality of second images includes comparing one or more first sections of a light pattern design with one or more second sections of the light pattern design within a single image. For the angular uniformity metric, the first light beams B**1** incoupled into the input coupler **121** undergo TIR until the incoupled first light beams B**1** are outcoupled (e.g., projected, such as reflected) to the first detector **312**.

The plurality of first metrics include a contrast metric. The contrast metric can represent a contrast between the brightest captured light within images and the darkest captured light within images. For the contrast metric, the processing of one or more of the plurality of first images or the plurality of second images includes comparing one or more bright sections of a light pattern design with one or more dark sections of the light pattern design within a single image. For the contrast metric, the first light beams B**1** incoupled into the input coupler **121** undergo TIR until the incoupled first light beams B**1** are outcoupled (e.g., projected, such as reflected) to the first detector **312**.

The plurality of first metrics include a color uniformity metric. The color uniformity metric can represent one or more ratios between the red light, the green light, and the blue light in a field. One or more of the plurality of first images, the plurality of second images, and/or the plurality of third images (described below in relation to FIG. **4**E) capture a red spectrum, a green spectrum, and a blue spectrum. For the color uniformity metric, the processing of one or more of the plurality of first images or the plurality

of second images includes comparing a red spectrum image with a green spectrum image and a blue spectrum image using the same field area. For the color uniformity metric, the first light beams B1 incoupled into the input coupler **121** undergo TIR until the incoupled first light beams B1 are outcoupled (e.g., projected, such as reflected) to the first detector **312**.

The plurality of first metrics include an efficiency metric. For the efficiency metric, prior to the capturing of the plurality of first images and the capturing of the plurality of second images, the second detector **316** is positioned to align with the input coupler **121** of the optical device **100** in a calibration position (shown in ghost for the second detector **316** in FIG. **4**A). While the second detector **316** is in the calibration position, the first light engine **310** directs calibration light beams toward the input coupler **121** of the optical device **100**, and the second detector **316** captures one or more calibration images of calibration projected light beams CP1 that project from the input coupler **121** of the optical device **100**. The one or more calibration images are full-field images. The second detector **316** is then positioned to align with the output coupler **122** of the optical device **100**. For the efficiency metric, the first light beams B1 incoupled into the input coupler **121** undergo TIR until the incoupled first light beams B1 are outcoupled (e.g., projected, such as reflected) to the first detector **312** and outcoupled (e.g., projected such as transmitted) to the second detector **316**. The first images are reflected images and the second images are transmitted images.

For the efficiency metric, the processing of one or more of the plurality of first images or the plurality of second images includes comparing the one or more calibration images with the plurality of first images and the plurality of second images.

The one or more first metrics include a modulation transfer function (MTF) metric. For the MTF metric, prior to the capturing of the plurality of first images and the capturing of the plurality of second images, directing calibration light beams from the first light engine **301** and toward the second detector **316**. The second detector **316** captures one or more calibration images of the calibration light beams while the second detector **316** is misaligned from the optical device **100**. The second detector **316** can be in the calibration position shown in ghost in FIG. **4**A and aligned with the first light engine **310**, while the optical device **100** can be positioned away from the second detector **316** to be out of the fields-of-view of the second detector **316** and the first light engine **310** (as shown in ghost for the optical device **100** in FIG. **4**A). The second detector **316** can then be positioned to align with the first detector **312**. In one embodiment, which can be combined with other embodiments, the second images are captured prior to the capturing of the first images. For the MTF metric, the first light beams B1 incoupled into the input coupler **121** undergo TIR until the incoupled first light beams B1 are outcoupled (e.g., projected, such as reflected or transmitted) to the first detector **312** or the second detector **316**.

For the MTF metric, the processing of one or more of the plurality of first images or the plurality of second images includes comparing an outer edge of one or more sections of the one or more calibration images with the same outer edge of the same one or more sections of one or more of the plurality of first images or the plurality of second images.

The plurality of first metrics include an eye box metric. For the eye box metric, the first detector **312** or the second detector **316** is moved to scan across a plurality of locations along the output coupler **122** of the optical device **100** during the capturing of the plurality of first images or the capturing of the plurality of second images. The processing of one or more of the plurality of first images or the plurality of second images includes comparing different images that correspond to different field areas of the output coupler **122**. For the eye box metric, the first light beams B1 incoupled into the input coupler **121** undergo TIR until the incoupled first light beams B1 are outcoupled (e.g., projected, such as reflected or transmitted) to the first detector **312** or the second detector **316**.

The plurality of first metrics include a ghost image metric. For the ghost image metric, prior to the capturing of the plurality of first images and the capturing of the plurality of second images, calibration light beams are directed from the first light engine **310** and toward the second detector **316**. The second detector **316** captures one or more calibration images of the calibration light beams while the second detector **316** is misaligned from the optical device **100**. The second detector **316** can be in the calibration position shown in ghost in FIG. **4**A and aligned with the first light engine **310**, while the optical device **100** can be positioned away from the second detector **316** to be out of the fields-of-view of the second detector **316** and the first light engine **310** (as shown in ghost for the optical device **100** in FIG. **4**A). The second detector **316** can then be positioned to align with the first detector **312**. In one embodiment, which can be combined with other embodiments, the second images are captured prior to the capturing of the first images.

For the ghost image metric, the processing of one or more of the plurality of first images or the plurality of second images includes comparing the one or more calibration images with one or more of the plurality of first images or the plurality of second images to determine an offset between the one or more calibration images and one or more of the plurality of first images or the plurality of second images. In one embodiment, which can be combined with other embodiments, the offset is an offset between a light pattern design (such as a reticle) in the one or more calibration images and the light pattern design (such as a reticle) in the first images or the second images.

FIG. **4**B is a schematic view of a configuration **400**B of the first subsystem **202** shown in FIGS. **2** and **3**A, according to one implementation. The configuration **400**B includes the first light engine **310**, the first detector **312**, and the second detector **316**. The first light engine **310** includes the first light source **402**, the first projection structure **404**, and the first lens **406**. The first light engine **310** in the configuration **400**B includes one or more two-dimensional Galvano mirrors **408** (such as an array of two-dimensional Galvano mirrors) configured to turn the first light beams emitted by the first projection structure **404** along a 90-degree turn toward the stage path **211**. In the implementation shown in FIG. **4**B, the first projection structure **404** and the first lens **406** are oriented perpendicularly to the stage path **211**.

The first detector **312** includes the second lens **410** and the first camera **412**. The second detector **316** includes the third lens **414** and the second camera **416**. The first light engine **310**, using the one or more two-dimensional Galvano mirrors **408**, turns the first light beams B1 along a 90 degree turn toward the stage path **211** and toward the input coupler **121** of the optical device **100**.

In the implementation shown in FIG. **4**B the first lens **406** is positioned between the first illuminator **401** and the stage path **211** along an optical path from the first illuminator and to the stage path **211**. The one or more two-dimensional Galvano mirrors **408** are positioned between the first lens

406 and the stage path 211 along the optical path. The optical path includes the 90 degree turn.

FIG. 4C is a schematic view of a configuration 400C of the first subsystem 202 shown in FIGS. 2 and 3A, according to one implementation. The configuration 400C is similar to the configuration 400A shown in FIG. 4A, and includes one or more of the aspects, features, components, and/or properties thereof.

The configuration 400C includes an alignment module 494. The alignment module 494 is shown in relation to the first light engine 310 to align the first projection structure 404 and the first lens 406. The alignment module 494 includes a laser source 495, a beam splitter 496, and an alignment detector 497. The alignment module 494 includes a pinhole 498 formed in a plate 499. The alignment detector 497 can include a camera. The alignment module 494 can be used in addition to the alignment detector 308.

The alignment module 494 is used to conduct an alignment operation. In the alignment operation, the first light source 402, the first projection structure 404 and the first lens 406 are moved out of alignment from the input coupler 121 of the optical device 100. The alignment module 494 directs first laser light L1 through the pinhole 498 and toward the optical device 100 using the laser source 495. A light intensity of first reflected laser light RL1 is determined using the alignment detector 497. The first reflected laser light RL1 is that first laser light L1 that reflects off of the optical device 100. The first reflected laser light RL1 is directed to the alignment detector 497 using the beam splitter 496. A tilt and a pitch of the laser source 495 is adjusted to increase the light intensity to an increased light intensity. A first position of the first reflected laser light RL1 received by the alignment detector 497 is determined at the increased light intensity. The first position is a position of the first reflected laser light RL1 within an image that the alignment detector 497 captures of the first reflected laser light RL1.

In the alignment operation, the first lens 406 is moved to be aligned with the input coupler 121 of the optical device 100 (as shown in ghost in FIG. 4C), and second laser light is directed through the pinhole 498 and toward the first lens 406. A tilt and a pitch of the first lens 406 is adjusted until a second position of second reflected laser light received by the alignment detector matches the first position of the first reflected laser light RL1. The second reflected laser light is the second laser light that reflects off of the first lens 406 and back toward the beam splitter 496.

In the alignment operation, the first projection structure 404 is moved to be aligned with the input coupler 121 of the optical device 100 (as shown in ghost in FIG. 4C), and third laser light is directed through the pinhole 498 and toward the first projection structure 404. A tilt and a pitch of the first projection structure 404 is adjusted until a third position of third reflected laser light received by the alignment detector matches the first position of the first reflected laser light RL1. The third reflected laser light is the third laser light that reflects off of the first projection structure 404 and back toward the beam splitter 496.

The alignment module 494 can then be moved out of alignment from the input coupler 121 of the optical device 100, and the first light source 402 can be moved into alignment with the input coupler 121 of the optical device 100. Lenses, projection structures, and cameras can be aligned using the alignment module 494 and the alignment operation to facilitate accurate operations, such as accurate determination of metrics of optical devices 100. The operations described for the alignment operation can be combined with the methods 1000, 1100, 1200 described below.

FIG. 4D is a schematic view of a configuration 400D of the first subsystem 202 shown in FIGS. 2 and 3A, according to one implementation. The configuration 400D includes the first light engine 310, the first detector 312, and the second detector 316. The first light engine 310 includes the first light source 402, the first projection structure 404, a first lens 406*a* positioned between the first illuminator 401, and a lens 406*b* positioned between the first lens 406*a* and the stage path 211. The first light engine 310 includes an adjustable aperture 407 positioned between the lens 406*b* and the first lens 406*a*. The adjustable aperture 407 can be formed in a plate 415. The adjustable aperture 407 can be adjusted by moving the adjustable aperture 407 upward and downward (such as by moving the plate 415) and/or by opening and closing the adjustable aperture 407.

The first light engine 310 can include the one or more devices 413 shown in FIG. 4A positioned between the lens 406*b* and the stage path 211. The first detector 312 includes a second lens 410 and a first camera 412. The second detector 316 includes a third lens 414 and a second camera 416. In one embodiment, which can be combined with other embodiments, each of the first lens 406, the first lens 406*a*, the lens 406*b*, the second lens 410 and/or the third lens 414 is formed of the same convex lens structure having the same radius of curvature. Each of the first lens 406, the first lens 406*a*, the lens 406*b*, the second lens 410 and/or the third lens 414 has the same lens structure. Using the same lens structure for the lenses facilitates compensating for optic aberrations, such as aberrations in reflection and/or transmission of light.

FIG. 4E is a schematic view of a configuration 400E of the second subsystem 204 shown in FIGS. 2 and 3B, according to one implementation. The configuration 400E includes the second light engine 360 and the face illumination detector 318. The second light engine 360 includes a second illuminator 461 and a fourth lens 466 positioned between the second illuminator 461 and the stage path 211. The second illuminator 461 includes a second light source 462 and a second projection structure 464. The second projection structure 464 and the fourth lens 466 are oriented parallel to the stage path 211.

The second projection structure 464 includes one or more of a display and/or a reticle. In one embodiment, which can be combined with other embodiments, the second projection structure 464 includes one or more of a microdisplay, a spatial light modulator (SLM), and/or a reticle. In one example, which can be combined with other examples, the SLM includes one or more of a digital micromirror device (DMD) and/or a liquid crystal on silicon (LCOS) emitter.

The face illumination detector 318 includes a third camera 426, a fifth lens 424 positioned between the third camera 426 and the stage path 211, and an eye box blocker 420 positioned between the fifth lens 424 and the stage path 211. The eye box blocker 420 is adjacent a face level 422.

The optical device 100 is positioned to align the input coupler 121 with the second light engine 360, and to align the output coupler 122 with the face illumination detector 318. Second light beams B2 are directed from the second light engine 360 and toward the input coupler 121 of the optical device 100. The face illumination detector 318 captures a plurality of third images (in addition to the first images and the second images described in relation to FIG. 4A) of third projected light beams BP3 that project from the output coupler 122 of the optical device 100.

The plurality of third images include the third projected light beams BP3 that project from the output coupler **122** of the optical device **100** and past the eye box blocker **420** of the face illumination detector **318**. The plurality of third images are processed (such as by using the controller **208**) to determine one or more second metrics of the optical device. The one or more second metrics include a display leakage metric.

FIG. **4**F is a schematic view of a configuration **400**F of the third subsystem **206** shown in FIGS. **2** and **3**C, according to one implementation. The third subsystem **206** includes the first light engine **310** mounted above the stage path **211** and configured to direct upper light beams toward the stage path **211**, and a second light engine **322** mounted below the stage path **211** and configured to direct lower light beams toward the stage path **211**.

The configuration **400**F includes a detector **320** mounted above the stage path **211** and configured to receive projected light beams projected from the stage path **211**. The projected light beams project from the optical device **100**. The first light engine **310** includes the first illuminator **401** and the first lens **406**. The detector **320** includes the second lens **410** and the first camera **412**. The second light engine **322** includes a device and a third lens.

The second light engine **322** comprises a second illuminator **471** and a second lens **476** positioned between the second illuminator **471** and the stage path **211**. The second illuminator **471** includes a second light source **472** and a second projection structure **474**. The second projection structure **474** is a display or a reticle. In one embodiment, which can be combined with other embodiments, a see-through transmittance metric of the optical device **100** is obtained using the configuration **400**F by illuminating the output coupling grating of the optical device **100** with the lower light beams emitted by the second light engine **322**.

The input coupler **121** of the optical device **100** is aligned with the first light engine **310** and the output coupler **122** is aligned with the second light engine **322**, as shown in FIG. **4**F. The detector **320** is aligned (e.g., vertically) with the second light engine **322** and misaligned from the first light engine **310**. The second light engine **322** directs first light beams LB**1** toward the output coupler **122**. Upper light beams LB**2** can be directed toward the input coupler **121** of the optical device **100** from the first light engine **310**. Using the detector **320**, a plurality of first images are captured of the first light beams LB**1** that transmit through the output coupler **122** and project from the output coupler **322** as first projected light beams PB**1**. The optical device **100** is positioned away from the second light engine **322** to misalign the optical device **100** from the second light engine **322** (as shown in ghost in FIG. **4**F for the optical device **100**) and position the optical device **100** out of field-of-views of the second light engine **322** and the detector **320**. Second light beams are directed from the second light engine **322** and toward the detector **320**. The detector captures a plurality of second images of the second light beams that project from the waveguide combiner as second projected light beams. The first images and the second images are full-field images. The first light beams and the second light beams are emitted (sequentially, for example) from the light engine in a red spectrum, a green spectrum, and a blue spectrum. The plurality of first images and the plurality of second images respectively capture the first light beams and the second light beams in the red spectrum, the green spectrum, and the blue spectrum. In one embodiment, which can be combined with other embodiments, the second images are captured prior to the first images.

The second images are compared with the first images (such as by using the controller **208**) to determine a see-through transmittance metric of the optical device **100**. In one embodiment, which can be combined with other embodiments, the comparing includes comparing a second light intensity of the plurality of second images with a first light intensity of the plurality of first images

FIG. **4**G is a schematic view of a configuration **400**G of the third subsystem **206** shown in FIGS. **2** and **3**C, according to one implementation. The configuration **400**G includes the detector **320**, and the first light engine **310**. The configuration **400**G includes a patterned substrate **490** positioned below the stage path **211**. The patterned substrate **490** includes a pattern design formed thereon. Each of the first light engine **310**, the patterned substrate **490**, and the detector **320** are positioned within the third body **201**C of the third subsystem **206**. In one embodiment, which can be combined with other embodiments, the patterned substrate **490** includes one or more of a plurality of protuberances **493** and/or a plurality of recesses **489** (shown in ghost in FIG. **4**G) that form the pattern design.

In an aligned position shown in FIG. **4**G, the patterned substrate **490** is aligned at least partially below the detector **320**, and the patterned substrate **490** is misaligned at least partially from the first light engine **310**. The optical device **100** below the detector **320** to align the optical device **100** with the detector **320**, and the optical device **100** is positioned above the patterned substrate **490** at a distance D**1** from the patterned substrate **490**.

The patterned substrate **490** directs lower light beams **491** toward the optical device **100**. The lower light beams **491** are reflected off of an upper surface of the patterned substrate **490** toward the optical device **100**. The lower light beams **491** transmit through the optical device **100** and are captured using the detector **320**. In one embodiment, which can be combined with other embodiments, the patterned substrate **490** reflects ambient light as the lower light beams **491**. In one embodiment, which can be combined with other embodiments, the patterned substrate **490** reflects light from a light engine, such as the second light engine **322**. In one embodiment, which can be combined with other embodiments, the configuration **400**G includes the second light engine **322** configured to direct light beams toward the patterned substrate **490**, and the patterned substrate **490** reflects the light beams from the second light engine **322** as the lower light beams **491**. The first light engine **310** includes the first light source **402**, the first projection structure **404**, and the first lens **406**. The detector **320** includes the second lens **410** and the first camera **412**.

The detector **320** captures a plurality of first images of projected light beams **492** that project from the output coupler **122** of the optical device **100** while the patterned substrate **490** is partially aligned with the detector **320** and partially misaligned from the detector **320** (as shown in FIG. **4**G). The plurality of first images capture a red spectrum, a green spectrum, and a blue spectrum of the projected light beams **492**. The plurality of first images are processed (such as by the controller **208**) to determine one or more see-through metrics of the optical device **100**.

The one or more see-through metrics include a see-through flare metric. For the see-through flare metric, the optical device **100** is positioned below the first light engine **310** to align the input coupler **121** of the optical device **100** with the first light engine **310**. First light beams LB**3** are directed from the first light engine **310** and toward the input coupler **121** of the optical device **100**. In such an embodiment, the projected light beams **492** include first light beams

LB3 from the first light engine **310** and lower light beams **491** reflected from the patterned substrate **490**. The first light beams LB3 are emitted from the first light engine **310** in a light pattern design that is different from the pattern design of the patterned substrate **490**.

The one or more see-through metrics include one or more of a see-through distortion metric and/or a see-through transmittance metric. For the see-through distortion metric and/or the see-through transmittance metric, the projected light beams **492** include light beams **491** reflected from the patterned substrate **490**. The optical device **100** is positioned away from the detector **320** to misalign the optical device **100** from the detector **320** and the patterned substrate **490** (as shown in ghost for the optical device **100** in FIG. **4**G) and position the optical device **100** out of field-of-views of the patterned substrate **490** and the detector **320**. The detector **320** captures a plurality of second images of reflected light beams that reflect from the patterned substrate **490** and toward the detector **320**. The plurality of second images capture the reflected light beams in the red spectrum, the green spectrum, and the blue spectrum. The processing of the plurality of first images includes comparing the plurality of second images with the plurality of first images to determine the see-through distortion metric and/or the see-through transmittance metric. In one embodiment, which can be combined with other embodiments, the second images are captured prior to capturing of the first images.

The one or more see-through metrics include a see-through ghost image metric. For the see-through ghost image metric, the optical device **100** is positioned away from the detector **320** to misalign the optical device **100** from the detector **320** and the patterned substrate **490**. The detector **320** captures a plurality of second images of reflected light beams that reflect from the patterned substrate **490** using the detector **320**. The plurality of second images capture the reflected light beams in the red spectrum, the green spectrum, and the blue spectrum. The processing of the plurality of first images includes determining an offset between the plurality of second images and the plurality of first images. In one embodiment, which can be combined with other embodiments, the offset is an offset between the pattern design (such as a reticle) in the first images and the pattern design (such as a reticle) in the second images.

FIG. **5** is a schematic view of an image **500**, according to one implementation. The image **500** includes a light pattern design (such as a reticle) having dark sections **501** and bright sections **502**. The image **500** can be used to determine the contrast metric and/or the angular uniformity metric.

For the angular uniformity metric, the processing includes comparing one or more first sections **502***a* of the light pattern design with one or more second sections **502***b*, **502***c* of the light pattern design within the image **500**. The first and second sections **502***a*, **502***b*, **502***c* correspond to bright sections **502**. The processing includes comparing light intensities of the one or more first sections **502***a* with light intensities of the one or more second sections **502***b*, **502***c*. The sections **502***a*, **502***b*, **502***c* are disposed at different radii relative to a center of the image **500**.

For the contrast metric, the processing includes comparing a light intensity of one or more bright sections **502***a* of the light pattern design with a light intensity of one or more dark sections **501***a* of the light pattern design within the image **500**. The bright section **502***a* has a light intensity I1 and the dark section **501***a* has a light intensity I2. The contrast metric can be determined and represented by the following Equation 1 as "C":

$$C = \frac{I1 - I2}{I1 + I2} \quad \text{(Equation 1)}$$

FIGS. **6**A-**6**C are schematic views of images **610**, **620**, **630**, according to one implementation. FIG. **6**A shows a red image **610**, FIG. **6**B shows a green image **620**, and FIG. **6**C shows a blue image **630**. The images **610**, **620**, **630** are used to determine the color uniformity metric. The processing includes comparing the images **610**, **620**, **630** using the same field area in each respective image **610**, **620**, **630**. The same field area includes one or more bright sections **602***a*-**602***c*, **603***a*-**603***c* at the same position in each image **610**, **620**, **630**. The color uniformity metric can represent a ratio of light intensities of the one or more bright sections **602***a*-**602***c*, **603***a*-**603***c* in each image **610**, **620**, **630**.

FIGS. **7**A-**7**C are schematic views of images **710**, **720**, **730**, according to one implementation. FIG. **7**A shows a calibration image **710**, FIG. **7**B shows a first image (e.g., a reflected image), and FIG. **7**C shows a second image (e.g., a transmitted image). The images **710**, **720**, **730** can be used to determine the efficiency metric.

The processing includes comparing the calibration image **710** with the first image **720** and the second image **730** using the same field area in each respective image **710**, **720**, **730**. The same field area includes one or more bright sections **702***a*-**702***c* at the same position in each image **710**, **720**, **730**. The processing includes comparing light intensities of the one or more bright sections **702***a*-**702***c* in the images **710**, **720**, **730**. The calibration image **710** includes a light intensity IC1 for the bright section **702***a*, the first image **720** includes a light intensity IR1 for the bright section **702***b*, and the second image **730** includes a light intensity IT1 for the bright section **702***c*.

The efficiency metric can be determined and represented by the following Equation 2 as "E":

$$E = \left(\frac{IR1}{IC1}\right) * \left(\frac{IT1}{IC1}\right) \quad \text{(Equation 2)}$$

FIG. **8** is a schematic view of an image **800**, according to one implementation. The image **800** includes a light pattern design (such as a reticle) having dark sections and bright sections. The image **800** can be used to determine the MTF metric. The processing includes comparing an edge area **832** of the one or more calibration images with the same edge area (e.g., the same position within the image) of the same one or more sections of one or more of the plurality of first images or the plurality of second images. The edge area **832** at least partially encompasses an outer edge **831** of one or more sections (such as a bright section).

FIGS. **9**A-**9**C are schematic views of images **910**, **920**, **930**, according to one implementation. Each of the images **910**, **920**, **930** shows a light pattern design that can be used for light directed by the first light engine **310**, the first light engine **370**, the second light engine **360**, the first light engine **370**, the second light engine **380**, the second light engine **322**, and/or the patterned substrate **490**. Each of the images **910**, **920**, **930** can be used to determine the ghost image metric and/or other metrics (such as other first metrics). Each of the images **910**, **920**, **930** respectively includes a plurality of dark sections **901***a*-**901***c* and a plurality of bright sections **902***a*-**902***c*.

FIG. **10** is a schematic block diagram view of a method **1000** of analyzing optical devices, according to one implementation.

Operation **1002** of the method **1000** includes positioning an optical device within a first subsystem to align the optical device with a first detector and a second detector of the first subsystem.

Operation **1004** includes directing first light beams from a first light engine of the first subsystem and toward the optical device. In one embodiment, which can be combined with other embodiments, the directing includes turning the first light beams along a 90 degree turn toward the stage path.

Operation **1006** includes capturing a plurality of first images of first projected light beams that project from the optical device using the first detector of the first subsystem.

Operation **1008** includes capturing a plurality of second images of second projected light beams that project from the optical device using the second detector of the first subsystem.

Operation **1010** includes processing one or more of the plurality of first images or the plurality of second images to determine a plurality of first metrics of the optical device. The first metrics include an angular uniformity metric, a contrast metric, an efficiency metric, a color uniformity metric, a modulation transfer function (MTF) metric, a field of view (FOV) metric, a ghost image metric, and/or an eye box metric.

Operation **1012** includes positioning the optical device within a second subsystem to align the optical device with a face illumination detector of the second subsystem.

Operation **1014** includes directing second light beams from a second light engine of the second subsystem and toward the optical device.

Operation **1016** includes capturing a plurality of third images of third projected light beams that project from the optical device using the face illumination detector of the second subsystem.

Operation **1018** includes processing the plurality of third images to determine one or more second metrics of the optical device. The one or more second metrics include a display leakage metric.

FIG. **11** is a schematic block diagram view of a method **1100** of analyzing optical devices, according to one implementation.

Operation **1102** of the method **1100** includes positioning an optical device above a light engine to align the optical device with the light engine.

Operation **1104** includes directing first light beams from the light engine and toward the optical device.

Operation **1106** includes capturing a plurality of first images of the first light beams that project from the optical device as first projected light beams using a detector.

Operation **1108** includes positioning the optical device away from the light engine to misalign the optical device from the light engine.

Operation **1110** includes directing second light beams from the light engine and toward the detector.

Operation **1112** includes capturing a plurality of second images of the second light beams.

Operation **1114** includes comparing the plurality of second images with the plurality of first images to determine a see-through transmittance metric of the optical device.

FIG. **12** is a schematic block diagram view of a method **1200** of analyzing optical devices, according to one implementation.

Operation **1202** of the method **1200** includes positioning an optical device below a detector to align the optical device with the detector.

Operation **1204** includes positioning the optical device above a patterned substrate at a distance from the patterned substrate. The patterned substrate includes a pattern design formed thereon.

Operation **1206** includes capturing a plurality of first images of projected light beams that project from the optical device using a detector while the patterned substrate is at least partially aligned with the detector.

Operation **1208** includes processing the plurality of first images to determine one or more see-through metrics of the optical device. The one or more see-through metrics include one or more of a see-through transmittance metric, a see-through distortion metric, a see-through flare metric, and/or a see through ghost image metric.

Benefits of the present disclosure include using a single optical device metrology system **200** to determine multiple metrology metrics (such as a display leakage metric, one or more see-through metrics, and one or more other metrology metrics) for a plurality of optical devices (such as waveguide combiners) on a single system using a single stage path **211**. In one embodiment, which can be combined with other embodiments, a single system using a single stage path **211** can be used to determine a display leakage metric, an angular uniformity metric, a contrast metric, an efficiency metric, a color uniformity metric, a modulation transfer function (MTF) metric, a field of view (FOV) metric, a ghost image metric, an eye box metric, a see-through distortion metric, a see-through flare metric, a see-through ghost image metric, and a see-through transmittance metric. Benefits also include increased throughput, reduced delays and costs, and enhanced efficiencies. The throughput is increased via the utilization of a feeding system coupled to each subsystem of the optical device metrology system.

It is contemplated that one or more aspects disclosed herein may be combined. As an example, one or more aspects, features, components, and/or properties of the optical device metrology system **200**, the first subsystem **202**, the second subsystem **204**, the third subsystem **206**, the configuration **400**A, the configuration **400**B, configuration **400**C, the configuration **400**D, the configuration **400**E, the configuration **400**F, the configuration **400**G, the image **500**, the images **610-630**, the images **710-730**, the image **800**, the images **910-930**, the method **1000**, the method **1100**, and/or the method **1200** may be combined. As an example, one or more of the operations described in relation to the optical device metrology system **200**, the subsystems **202**, **204**, **206**, and/or the configurations **400**A-**400**G can be combined with one or more of the operations described in relation to the method **1000**, the method **1100**, and/or the method **1200**. Moreover, it is contemplated that one or more aspects disclosed herein may include some or all of the aforementioned benefits.

While the foregoing is directed to embodiments of the present disclosure, other and further embodiments of the disclosure may be devised without departing from the basic scope thereof, and the scope thereof is determined by the claims that follow.

What is claimed is:

1. An optical device metrology system, comprising:

a stage configured to move a tray along a stage path;

a first light engine mounted above the stage path and configured to direct upper light beams toward the stage path;

a second light engine mounted below the stage path and configured to direct lower light beams toward the stage path;

a detector mounted above the stage path and configured to receive projected light beams projected from the stage path; and

a controller in communication with the stage, the first light engine, the second light engine, and the detector, the controller comprising instructions that, when executed, cause:

the stage to position an optical device above the second light engine to align an output coupler of the optical device between the light engine and the detector;

the second light engine to direct first light beams from the second light engine and toward the output coupler of the optical device;

the detector to capture a plurality of first images of the first light beams that project from the optical device as first projected light beams;

the stage to position the optical device away from the second light engine to misalign the output coupler of the optical device from the second light engine;

the second light engine to direct second light beams from the second light engine and toward the detector;

the detector to capture a plurality of second images of the second light beams; and

comparing of the plurality of second images with the plurality of first images to determine a see-through transmittance metric of the optical device.

2. The optical device metrology system of claim **1**, wherein the upper light beams and the lower light beams are emitted from the first light engine and the second light engine in a red spectrum, a green spectrum, and a blue spectrum, and the plurality of first images and the plurality of second images respectively capture the first light beams and the second light beams in the red spectrum, the green spectrum, and the blue spectrum.

3. The optical device metrology system of claim **2**, wherein the second light engine comprises an illuminator and a lens positioned between the illuminator and the stage path, the illuminator comprising a light source and a projection structure, the projection structure comprising one or more of a microdisplay, a spatial light modulator (SLM), or a reticle.

4. The optical device metrology system of claim **3**, wherein the detector comprises a camera and a lens positioned between the camera and the stage path.

5. An optical device metrology system, comprising:

a stage configured to move a tray along a stage path;

a first light engine mounted above the stage path and configured to direct upper light beams toward the stage path;

a second light engine mounted below the stage path and configured to direct lower light beams toward the stage path; and

a detector mounted above the stage path and configured to receive projected light beams projected from the stage path, the detector aligned with the second light engine and misaligned from the first light engine;

wherein:

each of the first and second light engines is configured to project an image;

the first light engine comprises a first illuminator and a first lens positioned between the first illuminator and the stage path, the first illuminator comprising a first light source and a first projection structure, the first projection structure comprises one or more of a microdisplay, a spatial light modulator, or a reticle; and

the second light engine comprises a second illuminator and a second lens positioned between the second illuminator and the stage path, the second illuminator comprising a second light source and a second projection structure, the second projection structure comprises one or more of a microdisplay, a spatial light modulator, or a reticle.

6. The optical device metrology system of claim **5**, further comprising a body having a first opening and a second opening to allow the stage to move through the first opening and the second opening.

7. The optical device metrology system of claim **6**, wherein each of the first light engine, the second light engine, and the detector are positioned within the body.

8. The optical device metrology system of claim **7**, wherein the detector comprises a camera and a third lens positioned between the camera and the stage path.

9. The optical device metrology system of claim **5**, further comprising a controller in communication with the first light engine, the second light engine, and the detector, the controller comprising instructions that, when executed, determine a see-through transmittance metric of an optical device supported on the tray.

10. The optical device metrology system of claim **5**, wherein the image includes a plurality of dark sections and a plurality of bright sections.

11. A method of analyzing optical devices, comprising:

positioning an optical device above a light engine to align an output coupler of the optical device between the light engine and a detector;

directing first light beams from the light engine and toward the output coupler of the optical device;

capturing a plurality of first images of the first light beams that project from the optical device as first projected light beams using the detector;

positioning the optical device away from the light engine to misalign the output coupler of the optical device from the light engine;

directing second light beams from the light engine and toward the detector;

capturing a plurality of second images of the second light beams; and

comparing the plurality of second images with the plurality of first images to determine a see-through transmittance metric of the optical device.

12. The method of claim **11**, wherein the first light beams and the second light beams are emitted from the light engine in a red spectrum, a green spectrum, and a blue spectrum.

13. The method of claim **12**, wherein the plurality of first images and the plurality of second images respectively capture the first light beams and the second light beams in the red spectrum, the green spectrum, and the blue spectrum.

14. The method of claim **11**, wherein the output coupler of the optical device is positioned above the light engine to align the output coupler between the light engine and the detector.

15. The method of claim **14**, further comprising directing upper light beams from an upper light engine and toward an input coupler of the optical device, wherein the upper light engine is positioned above the optical device.

16. The method of claim **14**, further comprising, prior to directing the first light beams, aligning the detector with the light engine.

17. The method of claim 11, wherein the comparing comprises comparing a second light intensity of the plurality of second images with a first light intensity of the plurality of first images.

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